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# Dielectric Measurements on High-Temperature Materials

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Cambridge, Massachusetts

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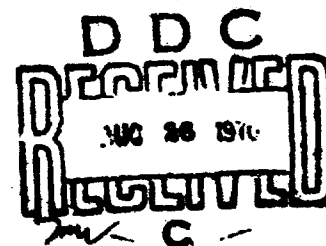
Technical Report AFML-TR-70-138

July 1970

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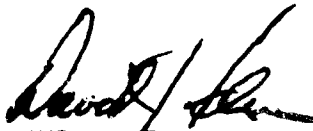
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## FOREWORD

This report was prepared by the Massachusetts Institute of Technology, Laboratory for Insulation Research, Cambridge, Massachusetts, under USAF Contract F33615-67C-1612. This Contract was initiated under Project No. 7371, "Exploratory Development in Electrical, Electronic, and Magnetic Materials," Task No. 737101, "Dielectric Materials." The work was administered under direction of the AF Materials Laboratory, with Mr. D. Evans acting as project engineer.

This Final Report covers work conducted from Nov. 1, 1966 to March 31, 1970, and was submitted on May 21, 1970, by the authors for publication.

This technical report has been reviewed and is approved



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# ABSTRACT

Extensions of the laboratory's measuring techniques for complex dielectric constants to wider ranges of temperature ( $4^{\circ}$  to  $2000^{\circ}\text{K}$ ) and frequency (.008 Hz to 90 GHz) are reviewed. Methods of interpreting dielectric data and computer programs for finding the components of complex spectra are discussed. Measurement data of general interest accumulated in the last three years appear in graphical and/or tabular form.

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## INTRODUCTION

A review of the general properties of high-temperature insulators has been previously given (Tech. Rep. 203). Since that time we have measured new samples of BN,  $\text{SiO}_2$ , sapphire, and spinel ( $\text{MgAl}_2\text{O}_4$ ), all of which have good high-temperature properties. These are listed in Section III and are indexed according to the same categories used in our previous review report 203. Sections I and II describe respectively measurement techniques and calculation procedures.

## MEASUREMENT TECHNIQUES

Since our last summary report on measurement methods (Tech. Rep. 182), the frequency and temperature ranges have been extended and different techniques have been used on special materials. These are briefly described in this section. Figure 1 shows graphically the frequency and temperatures available for measurement. The letter designations refer to equipment or methods as listed in the following summary.

### Summary of Methods of Measurement

- A. Laboratory-built three-terminal low-frequency bridge used mainly on another contract. For a description see Tech. Rep. 6 under Contract N00014-67A-0204-0003.
- B. Laboratory-built three-terminal high-frequency bridge, see above.
- C. Laboratory-built three-terminal bridge with automatic frequency scanning and recording. See Tech. Rep. 4 of above contract.
- D. Laboratory-built wide-range bridge, three-terminal 1 to  $10^5$  Hz, two-terminal 1 to  $4 \times 10^7$  Hz. See Tech. Rep. 201 under Contracts AF 33(616)-8353 and Nonr-1841(10).
- E. Susceptance variation method with reentrant cavity: (a) 60 to 100 MHz, 2-inch disks; (b) 300 MHz, 1-inch disks.
- F. Experimental Laboratory capacitance bridge, 50 MHz to 300 MHz.
- G. Standing-wave method with open-circuited line: (a) disk sample, 300 MHz to  $200^\circ\text{C}$ ; (b) coax sample, 100 to 300 MHz, R.T. only.
- H. Reentrant cavity with twin coaxial sample. Used only for good sensitivity ( $\tan \delta$  3 to  $5 \times 10^{-5}$ ) on coaxial samples at 300 MHz, R.T. only.
- I. Standing-wave method with coaxial sample  $\lambda/4$  away from short, near R.T. only.
- J. Standing-wave method with coaxial sample against short,  $-150$  to  $+500^\circ\text{C}$ .
- K. Standing-wave method with cylindrical sample,  $-150^\circ$  to  $1000^\circ\text{C}$  at 8.52 GHz, to  $800^\circ\text{C}$  at 14 and 24 GHz.
- L. Coaxial cavity, frequency variation method, 1 to 3 GHz,  $-195^\circ$  to  $+1400^\circ\text{C}$ .
- M. Dielectric-filled cylindrical cavity,  $-195^\circ$  to  $1500^\circ\text{C}$ , 3 to 6 GHz,  $-195^\circ$  to  $1700^\circ\text{C}$ , 9 GHz.
- N. Transmission bridge, free-space method, 90 GHz, under development.

The obvious gap in high-temperature measurements near  $10^8$  Hz could be remedied by construction of a doubly reentrant cavity as proposed in a previous report.<sup>1</sup> A model (Fig. 2) useful to about  $800^\circ\text{C}$ , using silver instead of platinum and iridium foils, is under construction and will be studied for expected temperature gradients.

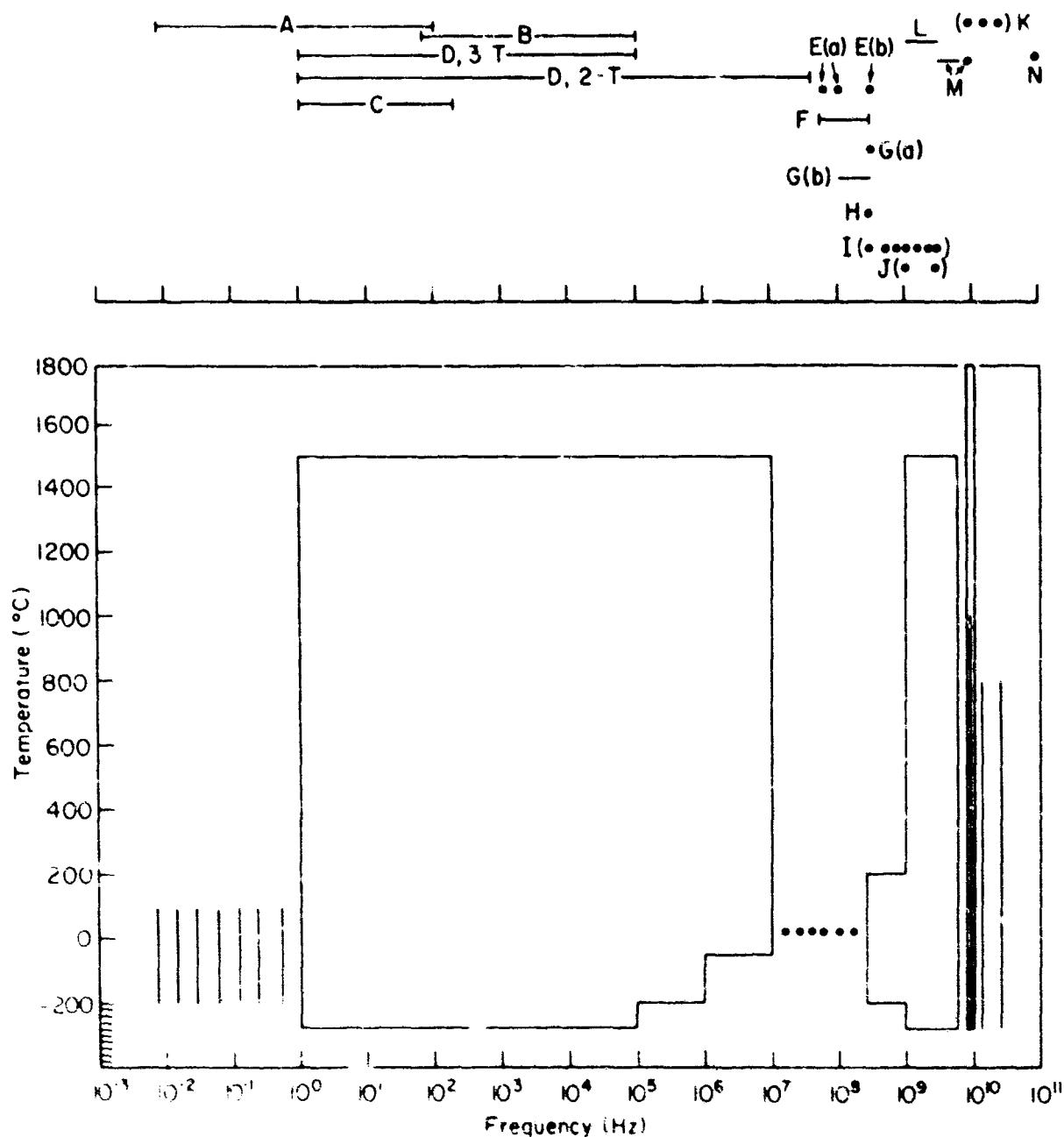


Fig. 1. Measurement methods and temperature ranges. See summary list for letter designations.

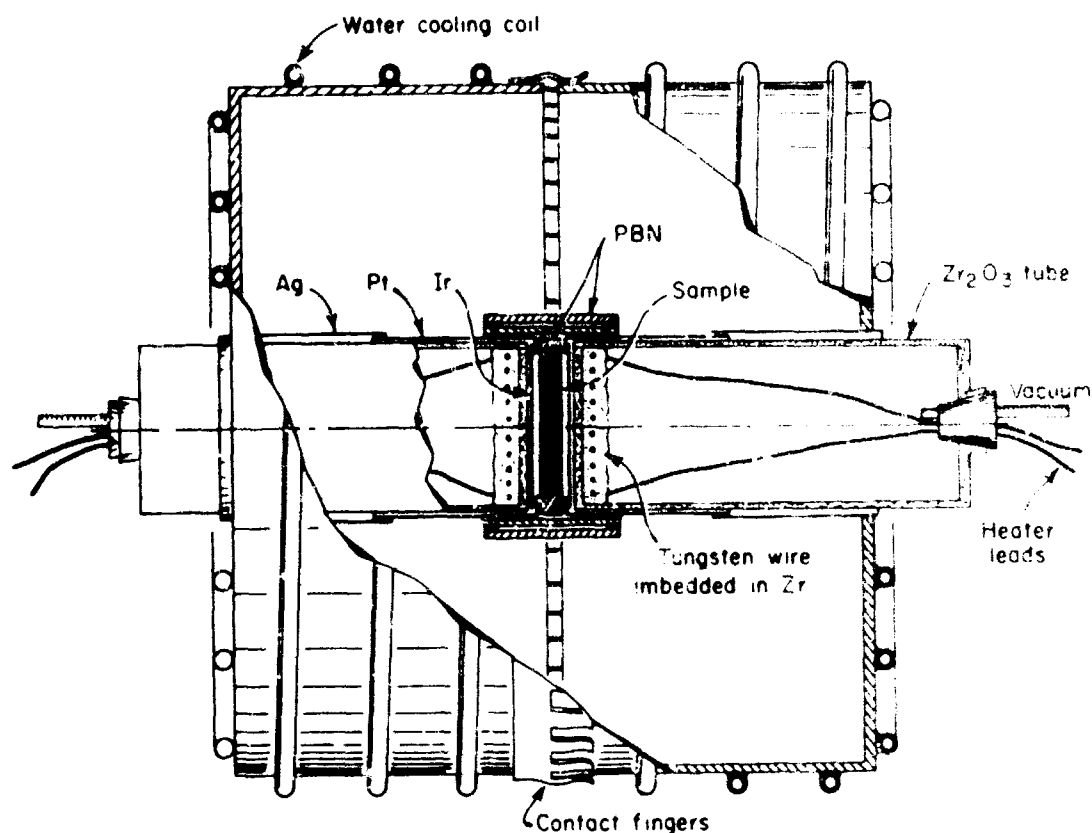


Fig. 2. High-temperature reentrant cavity (shown about 1/3 size for 100 MHz).

The 90-GHz measurements are still being developed.

For some of the data listed in Section III more than one method of measurement was used. An example is the Buda DiClad 522, which was supplied as doubly copper-clad sheet or as unclad sheet. With the clad sheet two-terminal and three-terminal samples were cut (Figs. 3a,b,c).

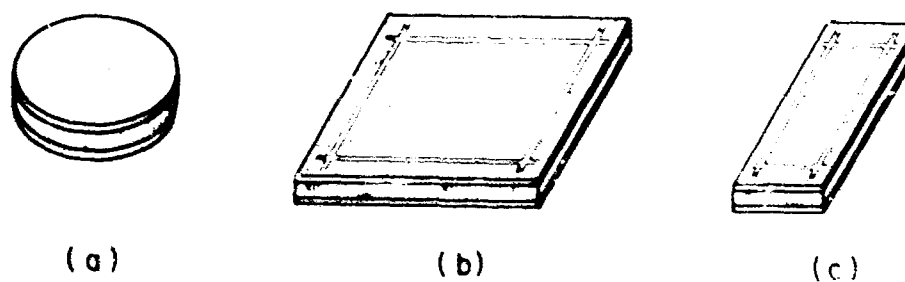


Fig. 3. Type of samples for copper-clad dielectrics. (a) Disk for two-terminal measurements. (b) Large square for precision three-terminal measurements. (c) Rectangular three-terminal sample for measurements in liquid-helium Dewar.

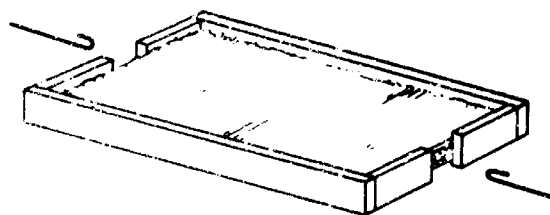


Fig. 4.  
Microwave dielectric-filled cavity  
formed of doubly-clad sheet stock.

For microwave measurements, pieces of the same stock were soldered to close the periphery of a rectangular piece as shown in Fig. 4. The resultant dielectric-filled cavity having a width of 4.449 cm and a length of 15.30 cm resonated in the  $TE_{104}$  mode at 3.14 GHz. A thickness measurement of the plate is not involved in the computation of the dielectric constant

$$\kappa' = \frac{\lambda^2}{4} \left[ \left( \frac{1}{w} \right)^2 + \left( \frac{4}{l} \right)^2 \right]^{1/2} \quad (1)$$

The equivalent loss tangent for copper loss was computed:

$$\tan \delta_w = \frac{\frac{1}{w} (w + 2t) + \left( \frac{4}{l} \right)^2 (l + 2t)}{1.31 \times 10^4 \text{ wt } \frac{\lambda}{s} \left[ \frac{1}{2} + \frac{4}{2} \right]^{3/2}}, \quad (2)$$

where  $s$  is the resistivity of the copper relative to its room-temperature resistivity. The value of  $\tan \delta_w$  was  $2.48 \times 10^{-4}$  at  $25^\circ\text{C}$  and was small compared to dielectric loss at all temperatures.

Measurements on deciad stock were made by using the three-terminal liquid displacement method<sup>2</sup> at  $10^4$  Hz and a rectangular cavity (as shown in Fig. 5) near 3 GHz.

Measurements were made with air-filled cavity (1), sample added (2), benzene (3), sample added (4). As in the three-terminal liquid displacement method, the four sets of data allow measurements of  $\kappa'$  without measurement of sample thickness:

$$\kappa'_s = \frac{\left[ \left( \frac{\lambda_3}{\lambda_1} \right)^2 \left( \frac{\lambda_3}{\lambda_4} \right)^2 - \left( \frac{\lambda_1}{\lambda_2} \right)^2 \right]}{\left( \frac{\lambda_3}{\lambda_4} \right)^2 - \left( \frac{\lambda_1}{\lambda_2} \right)^2} \kappa'_{\text{air}} \quad (3)$$

Equation 3 holds for any TE cavity but requires the same mode in all four measurements. Since the edge of the sample is in regions of low field strength, the length and width are not critical.

For measurements with H field, a single thickness (1/16 inch) unclad sample was located  $\lambda/4$  from the end of a coaxial line (Fig. 6a) or circular waveguide (Fig. 6b). The sources of errors and their magnitudes are listed. Stacking samples improves the sensitivity for measuring small losses. For accurate measure-

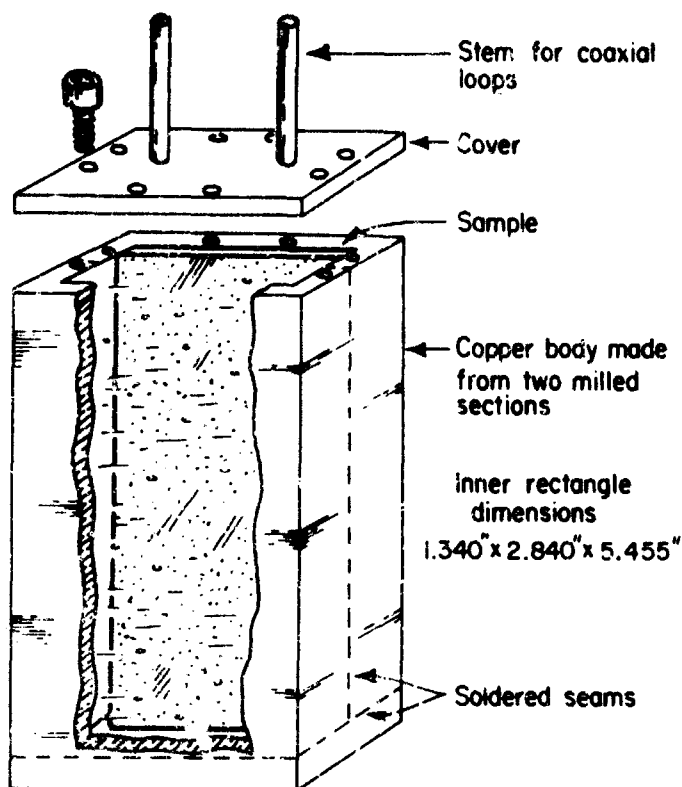


Fig. 5.  
Rectangular cavity for  
microwave measurement  
on sheet using liquid  
displacement.



At 3 GHz:		At 8.5 GHz; TE <sub>11</sub>	
Instrument repeatability	10 $\mu$	Instrument repeatability	5 $\mu$
1 mil uncertainty in clearance	.78	1 mil uncertainty in clearance	.06
1/2 mil " in thickness	.80	1/2 mil " in thickness	.80
	1.96		.97
$\tan \delta$ sensitivity	.00015	$\tan \delta$ sensitivity	.00015

Fig. 6. Standing-wave method with thin sample, located a quarter wavelength from end of line: (a) Coaxial line; (b) circular hollow waveguide TE<sub>11</sub> mode.

ments appropriate density corrections are used. Liquid immersion has been proposed but not used here.

In measurements on another glass-Teflon material (Duroid) data with both  $\perp$  and  $\parallel$  fields were required as a function of temperature for 1-inch thick stock. For these measurements, a thick-wall (0.81-inch) circular cavity (Fig. 7) was made of copper. Two disks of 1-3/8 inch diameter were press-fitted into the cavity. An oversized copper plunger was cooled in liquid nitrogen and then pressed into the die. The dielectric-filled cavity thus formed was operated in the TM<sub>010</sub> mode for  $E \perp$  measurements and in the TE<sub>111</sub> mode for  $E \parallel$ . As the material was heated,

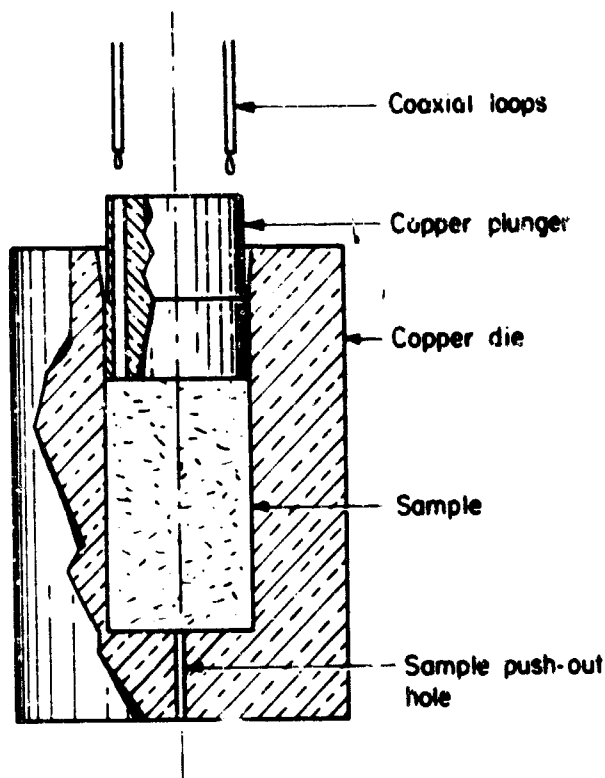


Fig. 7.

Thick-wall copper cavity for measurements or thick anisotropic laminates.

thermal expansion moved the plunger. This motion was monitored and thermal expansion of the copper was used in calculating the cavity dimensions for each temperature. The thermal expansion was large, and the sample remained 15% thicker after the run. In our knowledge, the precision and temperature range of this run are unique for this material.

#### COMPUTATIONS IN SPECTRUM ANALYSIS

The current trend for computers to program and control measurement procedure, to compute results and analyze them in terms of time or frequency has not yet led to completely automated dielectric spectroscopy. For the present we use the IBM 360 to compute values of dielectric constant and loss from instrument readings and to analyze frequency response.

##### Computation of $\kappa'$ , $\kappa''$

As an example of this first use we consider the calculation of dielectric constant and loss of a liquid contained as shown in Fig. 8 and measured by the standing-wave method in coaxial line (Program 1, Appendix). The sample holder is designed so that the region below the sample is  $\lambda/4$  long. Sample-out data are AN, the node, and  $\Delta X_A$  the node width and wavelength  $\lambda$ . Sample-in data are SN, the node, and  $\Delta X_S$  the node width. The basic transmission-line equations give boundary impedances ( $Z_{B1}$ ,  $Z_{B2}$ , ...) in terms of intrinsic-line constants ( $Z_0$ ,  $\gamma_n$ ) and line

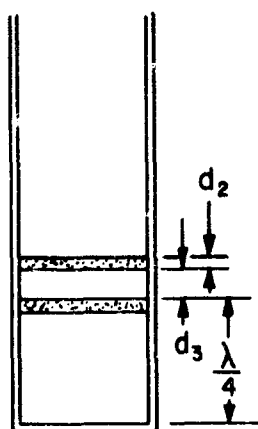


Fig. 8. Construction of sample holder section for high-loss liquids.

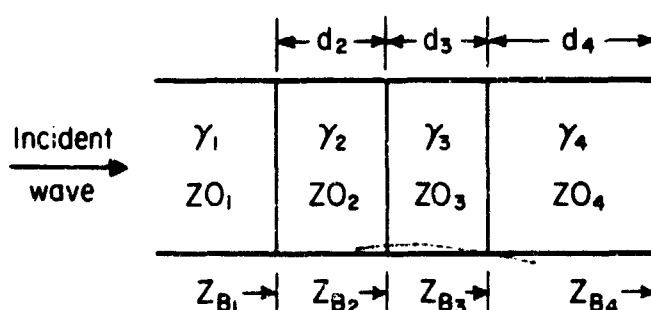


Fig. 9. Terminology for sections in liquid sample holder.

length  $d_n$  (Fig. 8). For Fig. 9 the general formulation for TE or TEM waves defines

$$\tanh \rho_{Bn} = \frac{Z_{Bn}}{Z_{O_n}}, \quad \tanh \rho_{B(n+1)} = \frac{Z_{B(n+1)}}{Z_{O(n+1)}}, \text{ etc.} \quad (4)$$

Then the impedance at a boundary  $Z_{Bn}$  is related to the impedance at the next boundary  $Z_{B(n+1)}$ :

$$\frac{Z_{Bn}}{\tanh[(\gamma d)_{(n+1)} + \rho_{(n+1)}]} = \frac{Z_{B(n+1)}}{\tanh \rho_{(n+1)}}. \quad (5)$$

The experimentally measured quantity is  $\tanh \rho_{B1}$ :

$$\tanh \rho_{B1} = \frac{E - j \tan 2\pi X_o / \lambda}{1 - j E \tan 2\pi X_o / \lambda} = \frac{X - jY}{1 - jXY} \equiv \frac{X - Z1}{1 - Z1X} = \frac{Z2}{Z3} = Z4, \quad (6)$$

where  $E$ , the inverse standing-wave ratio,

$$= \frac{\sin \pi \Delta X / \lambda}{(1 - \cos^2 \pi \Delta X / \lambda)^{1/2}} \equiv X, \quad (7)$$

and  $X_o$  is the distance from the first minimum to  $B1$ . In the above and the following equations the  $\equiv$  sign separates computer program terminology on the right from previous notation:

$$\tanh \rho_{B2} = \frac{Z_{B2} \tanh (\gamma_2 d_2 + \rho_{B2})}{Z_{B1}}, \quad (8)$$

$$\frac{\tanh \rho_{B1} - \frac{Z_{02}}{Z_{01}} \tanh \gamma_2 d_2}{\frac{Z_{02}}{Z_{01}} - \tanh \gamma_2 d_2 \cdot \tanh \rho_{B1}} \quad (9)$$

Substituting  $\gamma_1/\gamma_2$  for  $Z_{02}/Z_{01}$ ,

$$\frac{Z_{02}}{Z_{01}} \tanh \rho_{B2} = \frac{\tanh \rho_{B1} - \frac{\gamma_1}{\gamma_2} \tanh \rho_2 d_2}{1 - \frac{\gamma_2}{\gamma_1} \tanh \gamma_2 d_2 \tanh \rho_{B1}} \quad (10)$$

Neglecting losses in Section 2, the right-hand side reduces to

$$\frac{\tanh \rho_{B1} - j(1/\sqrt{\kappa_2'}) \tan(2\pi d_2 \kappa_2'/\lambda)}{1 - j \tanh \rho_{B1} \cdot \kappa_2' \tan(2\pi d_2 \kappa_2'/\lambda)} \equiv \quad (11)$$

$$\frac{Z_4 + j K_1}{1 + j K_2 \cdot Z_4} = \frac{Z_6}{Z_8} = \frac{1}{Z_9} \quad (12)$$

With Section 4 a quarter wavelength with negligible losses:

$$Z_{B2} = Z_{03} \coth \gamma_3 d_3 = Z_{02} \tanh \rho_{B2} \quad (13)$$

Substituting the right-hand side from Eq. 10,

$$Z_{01} \frac{\tanh \gamma_3 d_3}{Z_{03}} = Z_9; \quad (14)$$

then

$$\gamma_3 d_3 \tanh \gamma_3 d_3 = \gamma_1 d_3 Z_9 = j \frac{2\pi d_3}{\lambda} Z_9 \equiv \frac{Z_9}{K_3} = Z_{11} \quad (15)$$

Assuming that  $\gamma_3 d_3$  is small ( $<1$  radian) and substituting  $u$  for  $\gamma_3 d_3$ , we get

$$u \tanh u = u^2 - \frac{u^4}{3} = Z_{11} \quad (16)$$

Solving for  $u$  in terms of  $Z_{11}$ ,

$$u = [Z_{11} - \frac{1}{3} (Z_{11})^2]^{1/2} = Z_{12} S Q \quad (17)$$

The complex dielectric constant at this point in the program would be

$$\kappa' - j\kappa'' = (Z_{12} S Q \cdot K_3)^2 \quad (18)$$



Instead, the complex parts of  $u$  (A,B) are varied in steps until the equation

$$Z_{14} = u \tanh u = Z_{11} \quad (19)$$

is nearly satisfied. The final steps are 0.001% in both A and B. Line 39 defines the error. First B(DO 600), then A(DO 700), is varied. The final print-out lists sample node and  $\Delta X$ , the dielectric constant  $K_1$ , the loss factor  $K_2$ , the loss tangent TAN, and the two complex numbers  $Z_{11}$  and  $Z_{14}$  so the degree of matching can be confirmed. The total cost of calculating 68 data sets at \$2.09 per minute of calculation was \$1.47. Although the approximation of Eq. 16 is not good for samples longer than one radian, the iteration part of the program extends the range to at least 1.4 radians. For values greater than  $\pi/2$ , an underflow develops and stops the program.

A modification of the program (Program II, Appendix) uses arrays of node shifts (DN) and  $D^*$  values; thus charts such as Fig. 10 can be prepared to any desired accuracy to eliminate the need of further use of the computer for a particular sample holder. In principle the iteration procedure of these programs can be used to refine other calculations for any length of sample. Previously published computation procedures<sup>3)</sup> have been restricted in the upper limit of loss tangent.

### Spectrum Analysis

In our frequency range the fundamental problem of dielectric analysis is to determine from the wide-band frequency response the number and type of subspectra. One approach in analysis is to represent the total spectrum as the sum of subspectra, each having a single relaxation time. Mathematically the composite spectrum is represented as the sum of its components:

$$\kappa'(\omega) = \kappa_{\infty} + \frac{\Delta\kappa_1}{1 + \omega^2\tau_1^2} + \dots + \frac{\Delta\kappa_n}{1 + \omega^2\tau_n^2} \quad (20)$$

and

$$\kappa''(\omega) = \frac{\Delta\kappa_1}{1 + \omega^2\tau_1^2} \omega\tau_1 + \dots + \frac{\Delta\kappa_n}{1 + \omega^2\tau_n^2} \omega\tau_n + \frac{\sigma}{\omega\epsilon_0}, \quad (21)$$

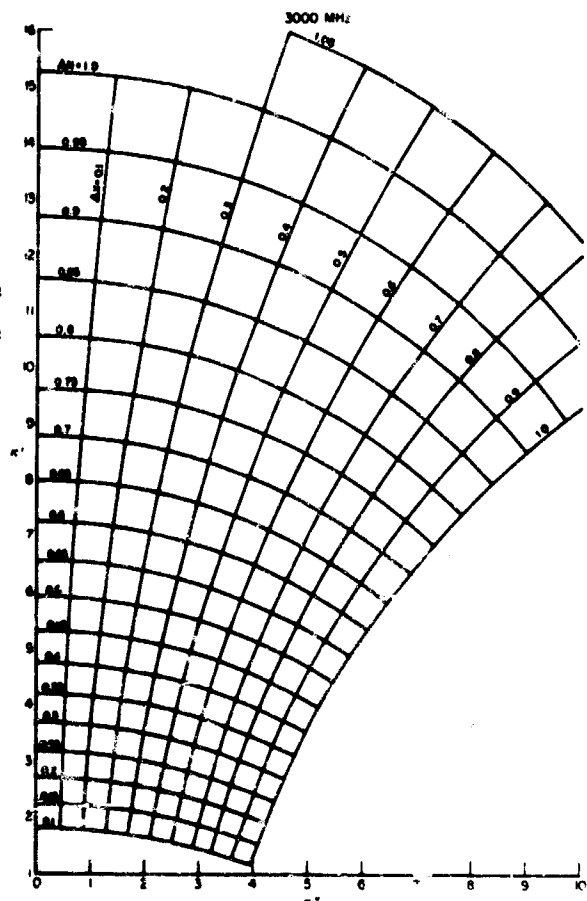


Fig. 10. Chart for finding  $\kappa'$ ,  $\kappa''$  in terms of node shift  $\Delta N$  and node width  $\Delta X$ .

where  $\kappa_{\infty}$  is the high-frequency (near infrared) dielectric constant,  $\sigma$  is the d-c conductivity (ohm-cm)<sup>-1</sup>,  $n$  is the number of relaxators,  $\epsilon_0$  is the dielectric constant of vacuum (fds/cm).

The purpose of Program III (Appendix), conceived and first executed by Dr. D. B. Knoll<sup>\*</sup> of this laboratory, is to find the number of components and compare the composite spectrum with the measured values. The initial portion of the program (to line 29) accepts a number (H) of capacitance and loss readings from a capacitance bridge and a second number (L) of readings from a low-frequency bridge. The parameters  $\kappa'(K1)$ ,  $\kappa''(K2)$ ,  $\omega\kappa''(K2W)$ ,  $\kappa''/\omega(K2dW)$  are computed for each measurement frequency.

The arrays of data are scanned (lines 31-83) to determine if measurement errors exist. Three criteria are involved in starting from the high frequency end for any combination of relaxators as in Eqs. 20 and 21:

$$1. \omega\kappa''(I) > \omega\kappa''(I+1), \quad (22)$$

$$2. \kappa'(I) < \kappa'(I+1), \quad (23)$$

$$3. \frac{\kappa'(I+1) - \kappa'I}{\omega\kappa''I - \kappa''(I+1)} = \tau > 0. \quad (24)$$

Print-out statements 42, 48, 56, 61, 71, 82 advise users of errors or equalities.

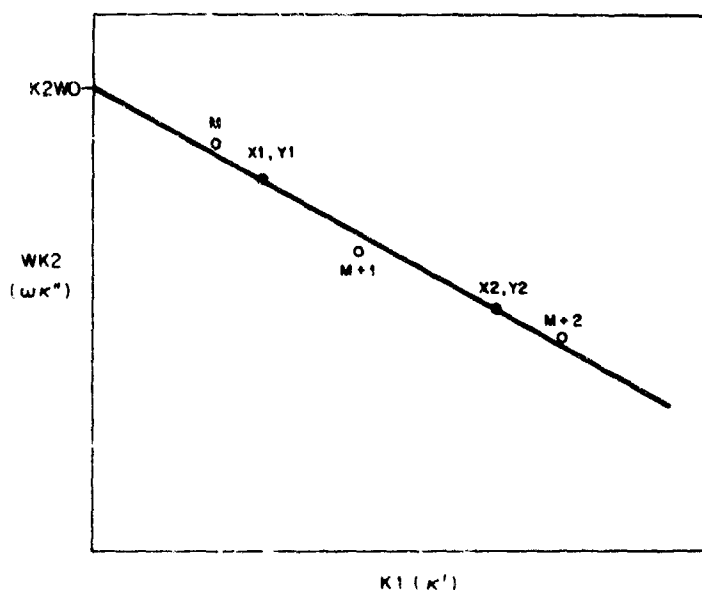


Fig. 11.

Terminology for initial line fit to three experimental points.

The Subroutine LINE fits a line to three successive experimental points according to Fig. 11.

\* Present address: Texas Instruments Corporation, Materials Research Group, Dallas, Texas.

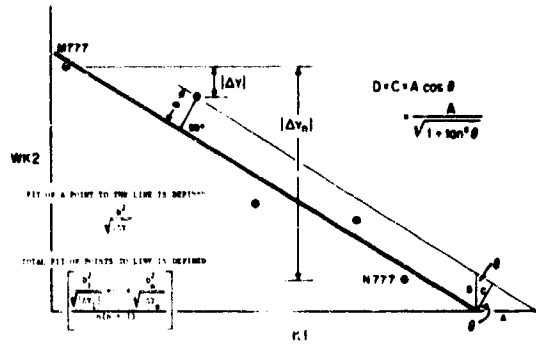


Fig. 12. Terminology for fit between line and experimental points.

Subroutine EROS is concerned with fit of the line to the points. The distance  $D(I)$  from a point (I) to line is shown in Fig. 12. In the figure  $\frac{A}{B} = \tau \tan \theta$ ;  $C = A \cos \theta = A/(1 + \tan^2 \theta)^{1/2}$ :

$$D(I) = C = \frac{\kappa'(I) + \tau \omega \kappa''(I) - \tau \kappa'' \omega(0)}{(1 + \tau^2)^{1/2}}, \quad (25)$$

$$SE = [D(I)]^2 / (|\Delta Y|)^{1/2}, \quad (26)$$

$$ERRER = \left[ \frac{[D(I)]^2}{(|\Delta Y_1|)^{1/2}} + \frac{[D(I+1)]^2}{(|\Delta Y_2|)^{1/2}} \right]^{1/2}. \quad (27)$$

More points are added to the array until ERRER increases. Subsequently both the slope (line 107) and high-frequency termination (line 116) are varied in steps to improve the fit. The final slope (line 141) determines  $\tau_1$ . The first calculation of  $\kappa_\infty$  follows using the high-frequency values of  $\kappa'$ . From (20),

$$\kappa'(I) = \kappa_\infty + \frac{\Delta \kappa_1}{1 + [\omega(I)\tau_1]^2}, \quad (28)$$

$$\kappa'(I+1) = \kappa_\infty + \frac{\Delta \kappa_1}{1 + [\omega(I+1)\tau_1]^2}. \quad (29)$$

Eliminating  $\Delta \kappa_1$  between Eq. 28 and 29 and solving for  $\kappa_\infty$  (line 155) yields

$$\kappa_\infty = \frac{\kappa'(I)\{1 + [\omega(I)\tau_1]^2\} - \kappa'(I+1)\{1 + [\omega(I+1)\tau_1]^2\}}{[\omega(I)\tau_1]^2 - [\omega(I+1)\tau_1]^2}. \quad (30)$$

Solving for  $K_1$  yields (line 147):

$$\Delta K_1 = \frac{\kappa'(I+1) - \kappa'(I)}{\frac{1}{1 + [\omega(I+1)\tau_1]^2} + \frac{1}{1 + [\omega(I)\tau_1]^2}}. \quad (31)$$

The high-frequency residue is regarded as the low-frequency contribution of a relaxator far outside the measuring range. The change in  $\kappa'$  with frequency in the measurement range is negligible, but the change in loss is obtained from the measured increment in  $\kappa''$  for two frequencies minus the same increment due to the first spectrum component. Neither the time constant nor  $\Delta K$  value of the off-range spectrum is known but their product is (line 162):

$$\Delta K_h \tau_h = \frac{(\omega \kappa'')_I - (\omega \kappa'')_{I+1} - \Delta K_1 \tau_1 \left[ \frac{\omega_I^2}{1 + (\omega_I \tau_1)^2} - \frac{\omega_{I+1}^2}{1 + (\omega_{I+1} \tau_1)^2} \right]}{\omega_I^2 - \omega_{I+1}^2}. \quad (32)$$

This high-frequency residue (HC) has a low-frequency counterpart (LC) at the other end of the measurement range. Here again neither the  $\Delta K$  nor  $\tau$  of an out-of-range spectrum can be found but their ratio  $\Delta K_h/\tau_h$  appears with the same effect as a d-c conductance component. From two successive values of  $\kappa''/\omega$  this component can be computed (line 173):

$$\frac{\Delta K_h}{\tau_h} = \frac{\left(\frac{\kappa''}{\omega}\right)_I - \left(\frac{\kappa''}{\omega}\right)_{I+1} - \Delta K_1 \tau_1 \left[ \frac{1}{1 + (\omega_I \tau_1)^2} - \frac{1}{1 + (\omega_{I+1} \tau_1)^2} \right]}{\frac{1}{\omega_I^2} - \frac{1}{\omega_{I+1}^2}}. \quad (33)$$

If no data have been taken at frequencies  $< \frac{1}{2\pi\tau_1}$ , the analysis is complete in that the number and magnitude of the relevant components have been determined. If lower frequency measurements exist, the contribution of HC and relaxator 1 are subtracted from each data point. These are now treated as new experimental points and the line fitting procedure is called again (205).

The approximate values of all unknowns LC,  $\Delta K_n$ ,  $\tau_n \dots \Delta K_1$ ,  $\tau_1$ , HC,  $\kappa_\infty$  are refined in steps in subroutine ERROR to achieve the best overall fit to the experimental points. Since the capacitance errors are usually less than conductance errors in our measurements, differences in the  $\kappa'$  fit are multiplied by 2, then added to differences in the  $\kappa''$  fit to establish the total error criteria (lines 16 to 18).

Obviously many modifications and uses of the program are possible. They are used to study the effect on measurement errors, to help decide the possibilities of hidden spectra and distributed time constants. There is a basic resolution problem in fitting a smooth curve to a series of experimental points with scatter that does not occur with "ideal" data. This makes the results of any curve-fitting program, such as ERROR, have some degree of dependence on the magnitude of the starting components. The difficulties arise because the function relating the total error to the magnitude of one-component is not a smooth function. In the future more automatic measurements will be made with decreased frequency separation. Then it may be feasible to smooth experimental errors before analysis.

#### REFERENCES

1. Semiannual Progress Report, April-September, 1967, Contract F33615-67C-1612.
2. See, for example, Standard D-1531, Carl Andeen et al., American Society for Testing Materials.
3. B. C. Gray, "Programming for Dielectric Constants," Electronic Industries, p. 106, August 1961; P. H. Gam and B. A. Schoomer, Jr., "A Speedy Method of Computing Dielectric Properties," *ibid.*, September 1963, p. 90.

## APPENDIX

## PROGRAM I

FORTRAN IV G LEVEL 1, MOD 3

MAIN

DATE = 70077

02/13/10

```

0001      REAL*8 K1,K2,K3,Y,XF,AN,SN,LW,DX,DS,DA,X,A,R,A2,R2,Z14RE,Z14IM,
0002      Z14LO,Z14LOO,Z14ROO,ERRORI,EROLD,AOLD,AIM,RE,TAN,Z11RE,Z11IM,COSINE
0003      COMPLEX*16 Z1,Z2,Z3,Z4,Z5,Z6,Z7,Z8,Z9,Z10,Z11,Z12,Z13,Z14R,Z14I,
0004      Z14,Z12NEW,Z12RF,Z12IM,Z12SO
0005      REAL STEP(4)/0.01,0.001,0.0001,0.00001/,F(2)/1.,-1./
0006      DIMENSION DS(200),SN(200),DATE(18)
0007      NAMELIST/IN/DS,SN,NX/CONST/DA,AN,XF,K1,K2,K3,LW/OUT/K1,K2,K3,LW
0008      200 FURMAT(1X,19A4)
0009      77 READ(5,200,FNO=99) DATE
0010      201 FURMAT(1H1,20X,19A4)
0011      WRITE(6,201) DATE
0012      READ(5,IN)
0013      READ(5,CONST)
0014      100 FORMAT(1H0,5X,2HNS,10X,2HDS,11X,2HK1,11X,2HK2,12X,3HTAN,20X,3HZ11,
0015      231X,3H714//)
0016      WRITE(6,100)
0017      DO 1C I=1,NX
0018      Y=6.2832*(XF-AN+SN(I))/LW
0019      DX=DS(I)-DA
0020      COSINE=DCOS(3.1416*DX/LW)**2
0021      X=DSIN(3.1416*DX/LW)/DSORT(2,-COSINE)
0022      Z1=(0.,1.)*DTAN(Y)
0023      Z2=X-Z1
0024      Z3=1.-Z1*Y
0025      Z4=Z2/Z3
0026      Z5=(0.,1.)*K1
0027      Z6=Z4+Z5
0028      Z7=(0.,1.)*K2
0029      Z8=1.+Z4*Z7
0030      Z9=Z8/Z6
0031      Z10=(0.,1.)/K3
0032      Z11=Z10*Z9
0033      Z11RE=REAL(Z11)
0034      Z11IM=AIMAG(Z11)
0035      Z12SO=DSORT(Z11+(1./3.)*Z11**2)
0036      A=REAL(Z12SO)
0037      R=AIMAG(Z12SO)
0038      A2=DTANH(A)*(1.+DTAN(R)**2)/(1.+DTANH(A)**2*DTAN(R)**2)
0039      R2=DTAN(R)*(1.-DTANH(A)**2)/(1.+DTANH(A)**2*DTAN(R)**2)
0040      Z14RE=A*A2-R*R2
0041      Z14IM=A*R2+R*A2
0042      ERROR1=DA8S((Z14RE-Z11RE)/Z11RE)+DA8S((Z14IM-Z11IM)/Z11IM)
0043      DO 400 K=1,4
0044      DO 600 J=1,2
0045      401 AOLD=A
0046      Z14LOO=Z14IM
0047      Z14ROO=Z14RE
0048      EROLD=ERROR1
0049      R=(1.+STEP(K)*F(J))
0050      A2=DTANH(A)*(1.+DTAN(R)**2)/(1.+DTANH(A)**2*DTAN(R)**2)
0051      R2=DTAN(R)*(1.-DTANH(A)**2)/(1.+DTANH(A)**2*DTAN(R)**2)
0052      Z14RE=A*A2-R*R2
0053      Z14IM=A*R2+R*A2
0054      ERROR1=DA8S((Z14RE-Z11RE)/Z11RE)+DA8S((Z14IM-Z11IM)/Z11IM)
0055      IF(ERROR1.LE.EROLD) GO TO 401
0056      Z14IM=Z14LOO
0057      Z14RE=Z14ROO
0058      R=EROLD
0059      ERROR1=EROLD
0060      CONTINUE
0061      DO 700 J=1,2
0062      402 AOLD=A
0063      Z14ROO=Z14RE
0064      Z14LOO=Z14IM
0065      EROLD=ERROR1
0066      A=(1.+STEP(K)*F(J))
0067      A2=DTANH(A)*(1.+DTAN(R)**2)/(1.+DTANH(A)**2*DTAN(R)**2)
0068      R2=DTAN(R)*(1.-DTANH(A)**2)/(1.+DTANH(A)**2*DTAN(R)**2)
0069      Z14RE=A*A2-R*R2
0070      Z14IM=A*R2+R*A2
0071      ERROR1=DA8S((Z14RE-Z11RE)/Z11RE)+DA8S((Z14IM-Z11IM)/Z11IM)

```

# PROGRAM I (cont.)

```

0060      IF(ERROR1.LE.F70L0) GO TO 400
0070      Z14RE=Z14R00
0071      Z14IM=Z14I00
0072      A=A0L0
0073      ERROR1=ER0L0
0074      700 CONTINUE
0075      400 CONTINUE
0076      Z12RF=(1.,0.)*A
0077      Z12IM=(0.,1.)*A
0078      Z12NFW=(Z12RE+Z12IM)**2
0079      Z13=-Z12NFW*K3**2
0080      Z14R=(1.,0.)=Z14RF
0081      Z14I=(0.,1.)*Z14IM
0082      Z14=Z14R+Z14I
0083      AIM=-AIMAG(Z13)
0084      RE=REAL(Z13)
0085      TAM=AIM/RE
0086      300 FJPMAT(2Y,F8.4,5X,F7.4,5X,F9.3,5X,F9.3,5X,F8.4,5X,E13.6,3X,E13.6,
      25X,F13.6,3X,E13.6)
0087      WRITE(6,300) SN(1),OS(1),RE,AIM,TAM,Z11,Z14
0088      10 CONTINUE
0089      WRITE(6,OUT)
0090      GO TO 77
0091      98 CALL EXIT
0092      END

```

## TYPICAL PRINT-OUT

NS	OS	K1	K2	TAN
0.5316	0.1478	75.084	13.954	0.1859
0.5280	0.1473	74.785	19.207	0.2568
0.5191	0.2270	75.403	24.038	0.3307
0.5381	0.2696	68.878	28.039	0.4071

Z11

Z14

-0.9761040-01	0.1876110-01	-0.9761070-01	0.1876110-01
-0.9710490-01	0.2581460-01	-0.9710580-01	0.2581450-01
-0.9778690-01	0.3353430-01	-0.9778620-01	0.3353420-01
-0.3894200-01	0.3748580-01	-0.3894290-01	0.3748570-01

## PROGRAM II

```

ORTRAN IV G LEVEL 1, MOD 3      MAIN      DATE = 70103      20/37/02

0001      REAL*8 K1,K2,K3,Y,XE,LW,CX,DN,D,X,A,B,A2,B2,Z14RE,Z14IM,COSINE,
      ZBOLD,Z14I00,Z14R00,ERROR1,ERCLD,ACLD,AIM,RE,TAM,Z11RE,Z11IM
0002      COMPLEX*16 Z1,Z2,Z3,Z4,Z5,Z6,Z7,Z8,Z9,Z10,Z11,Z12,Z13,Z14R,Z14I,
      Z14,Z12NEW,Z12RE,Z12IM,Z12SQ,Z2A
0003      COMPLEX*16 ZONE,ZONEI
0004      REAL STEP(4)/0.01,0.001,0.0001,0.00001/,F(2)/1.,-1./
0005      DIMENSION DATE(18),DN(9)
0006      NAMELIST/IN/DN,XE,LW,ND,NX,K1,K2,K3/OUT/K1,K2,K3,LW,X,Y,Z1,Z2,Z3,
      Z4,Z5,Z6,Z7,Z8,Z9,Z10,Z11
0007      ZONE=(1.,0.)
0008      ZONEI=(0.,1.)
0009      200 FORMAT(1X,18A4)
0010      77 READ(5,200,END=88) DATE
0011      201 FCRMAT(1H1,20X,18A4)
0012      WRITE(6,201) DATE
0013      READ(5,IN)
0014      100 FORMAT(1H0,5X,2HDX,10X,2HON,11X,2HK1,11X,2HK2,12X,3HTAN,20X,3HZ11,
      231X,3HZ14//)
0015      WRITE(6,100)
0016      DX=0.
0017      D=0.01
0018      DO 500 L=1,NX
0019      DX=DX+D
0020      IF(DX.EQ.0.) GO TO 500
0021      COSINE=DCOS(3.1416*DX/LW)**2
0022      X=DSIN(3.1416*DX/LW)/DSQRT(2.-COSINE)
0023      800 FORMAT(2X,F7.4)

```

PROGRAM II (CONT.)

```

0024      WRITE(6,800) DX
0025      DO 10 I=1,ND
0026      IF(DN(I).EQ.0.) GO TO 10
0027      Y=6.2832*(XE-DN(I))/LW
0028      Z1= ZONE1 + DTAN(Y)
0029      Z2=X-Z1
0030      Z2A=Z1*A
0031      Z3=ZONE-Z2A
0032      Z4=Z2/Z3
0033      Z5=ZONE1*K1
0034      Z6=Z4+Z5
0035      Z7=ZCNE1*K2
0036      Z8=ZONE+Z4*Z7
0037      Z9=Z8/Z6
0038      Z10=ZCNE1/K3
0039      Z11=Z10*Z9
0040      Z11RE=REAL(Z11)
0041      Z11IM=AIMAG(Z11)
0042      Z12SQ=CDSQRT(Z11+(1./3.)*Z11**2)
0043      A=REAL(Z12SQ)
0044      B=AIMAG(Z12SQ)
0045      A2=DTANH(A)*(1.+DTAN(B)**2)/(1.+DTANH(A)**2*DTAN(B)**2)
0046      B2=DTAN(B)*(1.-DTANH(A)**2)/(1.+DTANH(A)**2*DTAN(B)**2)
0047      Z14RE=A*A2-B*B2
0048      Z14IM=A*B2+B*A2
0049      ERROR1=DABS((Z14RE-Z11RE)/Z11RE)+DABS((Z14IM-Z11IM)/Z11IM)
0050      DO 400 K=1,4
0051      DO 600 J=1,2
0052      401 BOLD=B
0053      Z14IOD=Z14IM
0054      Z14ROC=Z14RE
0055      EROLD=ERROR1
0056      B=B*(1.+STEP(K)*F(J))
0057      A2=DTANH(A)*(1.+DTAN(B)**2)/(1.+DTANH(A)**2*DTAN(B)**2)
0058      B2=DTAN(B)*(1.-DTANH(A)**2)/(1.+DTANH(A)**2*DTAN(B)**2)
0059      Z14RE=A*A2-B*B2
0060      Z14IM=A*B2+B*A2
0061      ERRCLR1=DABS((Z14RE-Z11RE)/Z11RE)+DABS((Z14IM-Z11IM)/Z11IM)
0062      IF(ERROR1.LE.EROLD) GO TO 401
0063      Z14IP=Z14IOD
0064      Z14RE=Z14ROD
0065      B=BOLD
0066      ERROR1=EROLD
0067      600 CONTINUE
0068      DO 700 J=1,2
0069      402 ACLO=A
0070      Z14ROD=Z14RE
0071      Z14ICD=Z14IM
0072      ERCLD=ERRCLR1
0073      A=A*(1.+STEP(K)*F(J))
0074      A2=DTANH(A)*(1.+DTAN(B)**2)/(1.+DTANH(A)**2*DTAN(B)**2)
0075      B2=DTAN(B)*(1.-DTANH(A)**2)/(1.+DTANH(A)**2*DTAN(B)**2)
0076      Z14RE=A*A2-B*B2
0077      Z14IM=A*B2+B*A2
0078      ERROR1=DABS((Z14RE-Z11RE)/Z11RE)+DABS((Z14IM-Z11IM)/Z11IM)
0079      IF(ERROR1.LE.ERCLD) GO TO 402
0080      Z14RE=Z14ROD
0081      Z14IP=Z14ICD
0082      A=AOLD
0083      ERROR1=ERCLD
0084      700 CONTINUE
0085      403 CCATINUE
0086      Z12RE=ZONE*A
0087      Z12IM=ZONE1*B
0088      Z12NEW=(Z12RE+Z12IM)**2
0089      Z13=-Z12NEW*K3**2
0090      Z14R=ZONE*Z14RE
0091      Z14I=ZCNE1*Z14IM
0092      Z14=Z14R+Z14I

```



PROGRAM II (CONT.)

```

0093      AIM=-AIMAG(Z13)
0094      RE=REAL(Z13)
0095      TAM=AIM/RE
0096      300 FORMAT(14X,F8.4,5X,F9.3,5X,F9.3,5X,F8.4,5X,E13.6,3X,E13.6,
                25X,E13.6,3X,E13.6)
0097      WRITE(6,300) DN(1),RE,AIM,TAM,Z11,714
0098      10 CONTINUE
0099      500 CONTINUE
0100      WRITE(6,CUT)
0101      GO TO 77
0102      88 CALL EXIT
0103      END

```

PRINT-OUT

DX	DN	K1	K2	TAN
0.0100	1.0000	14.384	0.128	0.0089
	1.0500	15.728	0.142	0.0090
	1.1000	17.231	0.159	0.0092
	1.1500	18.923	0.180	0.0095
	1.2000	20.845	0.206	0.0099
	1.2500	23.054	0.237	0.0103
	1.3000	25.621	0.278	0.0108
	1.3500	28.643	0.329	0.0115
0.0200	1.4000	32.140	0.398	0.0124
	1.0000	14.382	0.255	0.0177
	1.0500	15.726	0.284	0.0180
	1.1000	17.228	0.318	0.0185
	1.1500	18.919	0.360	0.0190
	1.2000	20.841	0.411	0.0197
	1.2500	23.048	0.475	0.0206
	1.3000	25.613	0.555	0.0217
Z11	1.3500	28.634	0.658	0.0230
	1.4000	32.099	0.797	0.0248
Z14				
-0.4866340 00	0.5055130-02	-0.4866330 00	0.5055140-02	
-0.5408380 00	0.5815210-02	-0.5408270 00	0.5815210-02	
-0.6035880 00	0.6774950-02	-0.6035920 00	0.6774970-02	
-0.6772350 00	0.8010640-02	-0.6772360 00	0.8010650-02	
-0.7650760 00	0.9638830-02	-0.7650760 00	0.9638820-02	
-0.8718860 00	0.1184480-01	-0.8718870 00	0.1184490-01	
-0.1004840 01	0.1493790-01	-0.1004860 01	0.1493780-01	
-0.1175280 01	0.1946550-01	-0.1175300 01	0.1946550-01	
-0.1402140 01	0.2647350-01	-0.1394390 01	0.2647360-01	
-0.4865320 00	0.1010870-01	-0.4865240 00	0.1010970-01	
-0.5407110 00	0.1162830-01	-0.5407090 00	0.1162830-01	
-0.6034260 00	0.1354700-01	-0.6034190 00	0.1354700-01	
-0.6770230 00	0.1601720-01	-0.6770330 00	0.1601720-01	
-0.7647940 00	0.1927180-01	-0.7647780 00	0.1927170-01	
-0.8714580 00	0.2368080-01	-0.8714820 00	0.2368080-01	
-0.1004290 01	0.2986150-01	-0.1004270 01	0.2986150-01	
-0.1174450 01	0.3890660-01	-0.1174450 01	0.3890650-01	
-0.1400810 01	0.5290180-01	-0.1391090 01	0.5290200-01	

## PROGRAM IXX

FORTRAN IV G LEVEL 1, MOD 3

MAIN

DATE = 70098

13/12/07

```

0001      IMPLICIT REAL (K)
0002      DIMENSION FR(50),K1EX(50),K2EX(50),DATE(10),G(50),C(50),N(50),
          2F(50),GS(50),R(50),M(50),K1EXP(50),K2EXP(50),K1S(50),K2S(50),
          2X(50),X1(50),K1(50),K2(50),W(50),K2W(50),K2DW(50),B(50),PX(50)
0003      INTEGER H,Z,Z123
0004      REAL STEP(4)/0.1,0.02,0.005,0.001/
0005      REAL STEPP(R)/0.01,-0.01,0.004,-0.004,0.0015,-0.0015,0.0006,
          2-0.0006/
0006      NAMELIST/IN/CO,C,G,F,N,FR,R,M,H,L/TA/TAU/M7/M777/M9/M1/L9/L1/LE/
          2L1F
0007      10 READ(5,200,END=350)DATE
0008      200 FORMAT(1X,18A4)
0009      READ(5,IN)
0010      WRITE(6,201)DATE
0011      201 FORMAT(1H1///20X,18A4//)
0012      IF(H.EQ.0) GO TO 41
0013      DO 40 I=1,M
0014      GS(I)=G(I)*R(I)*M(I)/(10.*(1.+(R(I)/200C.))+G(I)*(1.E6+1000.*R(I)))
          6)
0015      40 CONTINUE
0016      IF(L.EQ.C) GO TO 38
0017      DO 50 I=1,L
0018      A=1.C/(1.0+(F(I)/1.01))*(1.0-F(I))*1.0E6*G(H+I)
0019      GS(H+I)=(G(H+I)*A*(N(I)+F(I)/1.01)*(1.0+1.0F4*A*G(H+I)*(N(I)+F(I)/
          21.01)))/(1.0+1.E4*A*G(H+I)*(N(I)+F(I)/1.01)-100.0*A*G(H+I)*(N(I)+
          2F(I)/1.01)**2)
0020      50 CONTINUE
0021      38 MN=H+L
0022      DO 222 I=1,MN
0023      K1EX(I)=C(I)/CO
0024      K2EX(I)=GS(I)/(6.2832*FR(I)*CO*1.E-12)
0025      K1(I)=K1EX(I)
0026      K2(I)=K2EX(I)
0027      W(I)=FR(I)*6.2832
0028      K2W(I)=K2(I)*W(I)
0029      K2DW(I)=K2(I)/W(I)
0030      222 CONTINUE
0031      Z123=1
0032      L1=MN
0033      413 743
0034      MEXIT=0
0035      M111=L1-1
0036      DO 224 I=Z123,M111
0037      M750=I
0038      IF(K2W(I).EQ.K2W(I+1)) GO TO 25
0039      GO TO 35
0040      25 K2W(I+1)=1.1*(K2W(I))
0041      20 FORMAT(1X,'FOUND K2W(I+1)=K2W(I) FIX UP TAKEN K2W(I+1)=1.1*K2W(I)
          2')
0042      WRITE(6,20)
0043      35 TAU=(K1(I+1)-K1(I))/(K2W(I)-K2W(I+1))
0044      IF(0.LT.TAU) GO TO 225
0045      224 CONTINUE
0046      GO TO 399
0047      225 M1=M750
0048      WRITE(6,M9)
0049      M222=L1-M1
0050      DO 260 I=1,M222
0051      J=L1-I
0052      IF(K2W(J).EQ.K2W(J+1)) GO TO 26
0053      GO TO 36
0054      26 K2W(J+1)=1.1*(K2W(J))
0055      21 FORMAT(1X,'FOUND K2W(J+1)=K2W(J) FIX UP TAKEN K2W(J+1)=1.1*K2W(J)
          2')
0056      WRITE(6,21)
0057      45 TAU=(K1(J+1)-K1(J))/(K2W(J)-K2W(J+1))
0058      IF(0.0.LT.TAU) GO TO 265
0059      260 CONTINUE
0060      265 L1E=J+1

```

```

                                PROGRAM III (CONT.)
0061      WRITE(6,LE)
0062      LI=LIE
0063      LID=LIE-1
0064      DO 650 I=M1,LID
0065      CHECK=K1(I+1)-K1(I)
0066      IF(0.0.LT.CHECK) GO TO 650
0067      IF(K2W(I).EQ.K2W(I+1)) GO TO 27
0068      GO TO 37
0069      27 K2W(I+1)=1.1*(K2W(I))
0070      22 FORMAT(1X,'FOUND K2W(M+1)=K2W(M) FIX UP TAKEN K2W(M+1)=1.1*K2W(M)
      2')
0071      WRITE(6,22)
0072      37 TAU=(K1(I+1)-K1(I))/(K2W(I)-K2W(I+1))
0073      IF(0.0.LT.TAU) GO TO 650
0074      LIC=I+1
0075      DO 651 J=LIC,LIE
0076      CHECK=(K1(J)-K1(I))/K1(I)
0077      IF(CHECK.LT.(-0.01)) GO TO 652
0078      651 CONTINUE
0079      650 CONTINUE
0080      GO TO 251
0081      652 LI=LIC-1
0082      WRITE(6,L9)
0083      251 M777=M1
0084      K2W0=0.0
0085      777 CALL LINE (M777,K1,K2W,TAU,K2W0,L1,MN)
0086      IF(Z.EQ.3) GO TO 304
0087      IF(TPREVS.LT.TAUT) GO TO 304
0088      788 M777=M777+1
0089      M777P=M777+2
0090      IF(M777P.GE.L1) GO TO 888
0091      WRITE(6,TA)
0092      GO TO 777
0093      304 IF(TAU.LE.0.0) GO TO 788
0094      M777P=M777+2
0095      IF(L1.LE.M777P) GO TO 290
0096      991 M777=M777+2
0097      ERRER=0.0
0098      CALL ERCS (M777,M777,TAU,K2W0,K1,K2W,ERRER)
0099      229 IF(M777.EQ.L1) GO TO 290
0100      227 ERRER1=ERRER
0101      M777=M777+1
0102      ERRER=0.0
0103      CALL ERCS (M777,M777,TAU,K2W0,K1,K2W,ERRER)
0104      IF(ERRER.LE.ERRER1) GO TO 229
0105      TAUOLD=TAU
0106      K2WOLD=K2W0
0107      DO 400 J=1,8
0108      228 ERRERT=ERRER
0109      TAUT=TAU
0110      TAU=TAUT*(1.+STEPP(J))
0111      ERRER=0.0
0112      CALL ERCS (M777,M777,TAU,K2W0,K1,K2W,ERRER)
0113      IF(ERRER.LE.ERRER1) GO TO 229
0114      IF(ERRER.LT.ERRERT) GO TO 228
0115      TAU=TAUT
0116      ERRER=ERRERT
0117      301 ERREKN=ERRER
0118      K2WON=K2W0
0119      K2W0=K2WON-K2W(M777)*STEPP(J)*0.1
0120      ERRER=0.0
0121      CALL ERCS (M777,M777,TAU,K2W0,K1,K2W,ERRER)
0122      IF(ERRER.LE.ERRER1) GO TO 229
0123      IF(ERRER.LT.ERREKN) GO TO 301
0124      K2W0=K2WON
0125      ERRER=ERREKN
0126      400 CONTINUE
0127      TAU=TAUOLD
0128      IF(Z.EQ.3) GO TO 401
0129      IF(TPREVS.LT.TAU) GO TO 401
0130      402 M777=M777
0131      GO TO 777
0132      401 K2W0=K2WOLD

```

```

                                PROGRAM III (CONT.)
0133      IF(L1.LE.N777) GO TO 291
0134      MOLD=M777
0135      M777=M777
0136      CALL LINE (M777,K1,K2W,TAU,K2WD,L1,MN)
0137      IF(TAU.LT.TAUOLD) GO TO 303
0138      GU TO 678
0139      303 IF(3.LT.Z) GO TO 304
0140      M1=M777
0141      WRITE(6,M9)
0142      GO TO 304
0143      678 M777=MOLD
0144      TAU=TAUOLD
0145      291 X(Z+1)=TAU
0146      TPREV5=TAU
0147      KK=0.0
0148      N776=M777-1
0149      DO 960 I=M777,M776
0150      R(I)=(K1(I+1)-K1(M777))/(1./(1.+(W(I+1)*TAU)**2)-1./(1.+(W(M777
2)*TAU)**2))
0151      KK=KK+R(I)
0152      960 CONTINUE
0153      X(Z)=KK/(M777-M777)
0154      IF(X(Z).LT.0.0) GO TO 402
0155      IF(3.LT.Z) GO TO 921
0156      XXKINF=0.0
0157      DO 910 I=M777,M776
0158      XKINF=(K1(M777)*(1.+(W(M777)*TAU)**2)-K1(I+1)*(1.+(W(I+1)*TAU
2**2)))/(W(M777)*TAU**2-(W(I+1)*TAU)**2)
0159      XXKINF=XXKINF+XKINF
0160      910 CONTINUE
0161      X(1)=XXKINF/(M777-M777)
0162      XXHC=0.0
0163      HSTORD=0.0
0164      DO 920 I=M777,M776
0165      XHCXHC=((K2W(M777)-K2W(I+1))-B(I)*TAU*(W(M777)**2/(1.+(W(M777)*
2TAU)**2)-W(I+1)**2/(1.+(W(I+1)*TAU)**2)))/(W(M777)**2-W(I+1)**2)
0166      IF(XHCXHC.LT.0.0) GO TO 483
0167      IF(HSTORD.EQ.0.0) GO TO 482
0168      IF(HSTORD.LT.XHCXHC) GO TO 483
0169      482 HSTORD=XHCXHC
0170      483 XXHC=XXHC+XHCXHC
0171      920 CONTINUE
0172      X(2)=XXHC/(M777-M777)
0173      921 XXLC=0.0
0174      XSTORD=0.0
0175      DO 922 I=M777,M776
0176      XLCXLC=(K2DW(M777)-K2DW(I+1)-B(I)*TAU*(1./(1.+(W(M777)*TAU)**2)
2-1./(1.+(W(I+1)*TAU)**2)))/(1./W(M777)**2-1./W(I+1)**2)
0177      IF(XLCXLC.LT.0.0) GO TO 481
0178      IF(XSTORD.EQ.0.0) GO TO 480
0179      IF(XSTORD.LT.XLCXLC) GO TO 481
0180      480 XSTORD=XLCXLC
0181      481 XXLC=XXLC+XLCXLC
0182      922 CONTINUE
0183      X(Z+2)=XXLC/(M777-M777)
0184      IF(MEXIT.EQ.1) GO TO 999
0185      DO 320 I=M777,L1
0186      SK1SK1=X(Z)/(1.+(W(I)*TAU)**2)
0187      IF(3.LT.Z) GO TO 307
0188      SK1SK1=SK1SK1+X(1)
0189      307 X1(I)=K1(I)-SK1SK1
0190      SK2W=X(Z)*W(I)**2*TAU/(1.+(W(I)*TAU)**2)
0191      K2W(I)=K2W(I)-SK2W
0192      SK2DW=X(Z)*TAU/(1.+(W(I)*TAU)**2)+X(2)
0193      222 K2DW(I)=K2DW(I)-SK2DW
0194      220 CONTINUE
0195      GO TO 370
0196      290 MEXIT=1
0197      N777=L1
0198      GU TO 291
0199      270 DO 710 I=M777,L1
0200      M751=I

```

PROGRAM III (CONT.)

```

0201      ABAB=1.0/W(1)
0202      IF(X(2+1).LE.88AB) GO TO 711
0203      710 CONTINUE
0204      711 M777=M751
0205      IF(L1.LT.(M777+1)) GO TO 999
0206      WRITE(6,M7)
0207      Z=Z+2
0208      GO TO 777
0209      999 NX=Z+2
0210      IF(0.0.LT.X(NX)) GO TO 731
0211      X(NX)=XSTORD
0212      731 IF(0.0.LT.X(2)) GO TO 666
0213      X(2)=HSTORD
0214      666 NF=NX-2
0215      DO 551 J=3,NP,2
0216      XRE=X(J)
0217      X(J)=X(J+1)
0218      X(J+1)=XRE
0219      551 CONTINUE
0220      DO 441 I=1,NX
0221      PX(I)=X(I)
0222      441 CONTINUE
0223      X(1)=PX(NX)
0224      NXC=NX-1
0225      DO 331 J=1,NXC
0226      X(J+1)=PX(NX-J)
0227      331 CONTINUE
0228      DO 333 I=1,NX
0229      XI(I)=X(I)
0230      333 CONTINUE
0231      MMM=2
0232      CALL ERROR(NX,M),K15,X,K25,FR,K1EX,K2EX,SUM,K1EXP,K2EXP,L1,SUMK1,
2SUMK2)
0233      SUMOLD=SUM
0234      SUM1=0.
0235      DO 500 J=1,4
0236      701 DO 700 L=1,MMM
0237      SUM2=SUM1
0238      DO 600 I=1,NX
0239      XOLD=X(I)
0240      X(I)=X(I)*(1.+STEP(J))
0241      CALL ERROR(NX,M1,K15,X,K25,FR,K1EX,K2EX,SUM,K1EXP,K2EXP,L1,SUMK1,
2SUMK2)
0242      IF(SUM.LT.SUMOLD) GO TO 501
0243      X(I)=XOLD
0244      X(I)=X(I)*(1.-STEP(J))
0245      CALL ERROR(NX,M1,K15,X,K25,FR,K1EX,K2EX,SUM,K1EXP,K2EXP,L1,SUMK1,
2SUMK2)
0246      IF(SUM.LT.SUMOLD) GO TO 601
0247      X(I)=XOLD
0248      SUM1=SUMOLD
0249      GO TO 600
0250      601 SUM1=SUM
0251      SUMOLD=SUM
0252      600 CONTINUE
0253      700 CONTINUE
0254      IF(SUM1.LT.SUM2) GO TO 900
0255      GO TO 555
0256      500 MMM=1
0257      GO TO 701
0258      555 MMM=1
0259      SUM1=SUM2
0260      500 CONTINUE
0261      507 FORMAT(1H0,13X,8HXINITIAL,5X,9HXCOMPUTED//)
0262      WRITE(6,507)
0263      115 FORMAT(1X,2HLC,8X,E12.5,3X,E12.5)
0264      WRITE(6,115) XI(1),X(1)
0265      NT=NX-3
0266      DO 112 I=2,NT,2
0267      113 FORMAT(1X,7HKS-KINF,3X,E12.5,3X,E12.5)
0268      WRITE(6,113) XI(I),X(I)
0269      114 FORMAT(1X,3HTAL,7X,E12.5,3X,E12.5)

```

```

                                PROGRAM III (CONT.)
0270      WRITE(6,114) XI(I+1),X(I+1)
0271      112 CONTINUE
0272      111 FORMAT(1X,2HMC,4X,E12.5,3X,F12.5)
0273      WRITE(6,111) XI(NX-1),X(NX-1)
0274      508 FORMAT(1X,4HKINF,6X,E12.5,3X,E12.5)
0275      WRITE(6,508) XI(NX),X(NX)
0276      509 FORMAT(/,1H0,5X,2HFR,12X,4HK1EX,13X,3HK1S,12X,4HK2EX,13X,3HK2S,
        211X,6HK1EX 8,11X,6HK2EX 8//)
0277      WRITE(6,509)
0278      510 FORMAT(1X,E12.5,3X,E12.5,3X,E12.5,3X,E12.5,3X,E12.5,3X,F12.5,3X,
        2F12.5)
0279      WRITE(6,510) (FR(I),K1EX(I),K1S(I),K2EX(I),K2S(I),K1EXP(I),
        2K2EXP(I),I=M1,LI)
0280      801 FORMAT(73X,5HSUM =,F11.5,5X,F11.5)
0281      WRITE(6,801) SUMK1,SUMK2
0282      IF(L1.EQ.LI) GO TO 10
0283      L123=L1+1
0284      L1=L1E
0285      GO TO 413
0286      888 GO TO 10
0287      350 CALL EXIT
0288      END

```

TOTAL MEMORY REQUIREMENTS 002F7A BYTES

FORTRAN IV G LEVEL 1, MOD 3                      ERROR                      DATE = 70098                      13/12/07

```

0001      SUBROUTINE ERROR (NX,M1,K1S,X,K2S,FR,K1EX,K2EX,SUM,K1EXP,K2EXP,
        2L1,SUMK1,SUMK2)
0002      IMPLICIT REAL (K)
0003      DIMENSION K1S(50),X(50),K2S(50),FR(50),K1EX(50),K2EX(50),
        2K1EXP(50),K2EXP(50)
0004      NJ=JX-3
0005      NW=NX-1
0006      SUM=0.
0007      SUMK1=0.
0008      SUMK2=0.
0009      DO 100 I=M1,L1
0010      K1S(I)=X(NX)
0011      K2S(I)=X(NW)*6.2832*FR(I)+X(I)/(6.2832*FR(I))
0012      DO 101 J=2,NJ,2
0013      K1S(I)=K1S(I)+X(J)/(1.+(6.2832*FR(I)*X(J+1))**2)
0014      K2S(I)=K2S(I)+X(J)*6.2832*FR(I)*X(J+1)/(1.+(6.2832*FR(I)*X(J+1))
        2**2)
0015      101 CONTINUE
0016      DK1=(K1EX(I)-K1S(I))/K1EX(I)*2
0017      DK2=(K2EX(I)-K2S(I))/K2EX(I)
0018      SUM=SUM+ABS(DK1)+ABS(DK2)
0019      K1EXP(I)=DK1*50.
0020      K2EXP(I)=DK2*100.
0021      SUMK1=SUMK1+ABS(K1EXP(I))
0022      SUMK2=SUMK2+ABS(K2EXP(I))
0023      100 CONTINUE
0024      RETURN
0025      END

```

TOTAL MEMORY REQUIREMENTS 000486 BYTES

FORTRAN IV G LEVEL 1, MOD 3                      ERROR                      DATE = 70098                      13/12/07

```

0001      SUBROUTINE EROS (M777,N777,TAU,K2W0,K1,K24,ERRR)
0002      IMPLICIT REAL (K)
0003      DIMENSION K1(50),K2W(50),D(50),DS(50)
0004      DO 200 I=M777,N777
0005      D(I)=(K1(I)+TAU*K2W(I)-TAU*K2W0)/SQRT(1.+(TAU**2)
0006      200 CONTINUE
0007      M778=M777+1
0008      SF=0.0

```

```

          PROGRAM III (CONT.)
0009      IF(K2W(M777).EQ.K2W(M778)) GO TO 202
0010      SE=(D(M777)**2/SQRT(ABS(K2W(M777)-K2W(M778))))
0011      202 DO 201 I=M778,M777
0012      IF(K2W(M777).EQ.K2W(I)) GO TO 110
0013      DS(I)=(D(I)**2/SQRT(ABS(K2W(M777)-K2W(I))))
0014      GO TO 115
0015      110 DS(I)=0.
0016      120 FORMAT(1X,'EROS K2W(M777)=K2W(I) FIX UP DS(I)=0. ')
0017      WRITE(6,120)
0018      115 SE=SE+DS(I)
0019      201 CONTINUE
0020      IF(K2W(M777).EQ.K2W(M778)) GO TO 204
0021      ERRER=SQRT(SE/((M777-M777)*(M777-M777+1)))
0022      GO TO 205
0023      204 ERRER=SQRT(SE/((M777-M777-1)*(M777-M777)))
0024      205 RETURN
0025      END

```

TOTAL MEMCRY REQUIREMENTS 000668 BYTES

FORTRAN IV G LEVEL 1, MOD 3                      LINE                      DATE = 70098                      13/12/07

```

0001      SUBROUTINE LINE (M777,K1,K2W,TAU,K2WO,L1,MN)
0002      IMPLICIT REAL (K)
0003      DIMENSION K1(50),K2W(50)
0004      M=M777
0005      40 FORMAT(1X,13,3X,13)
0006      WRITE(6,40) M,L1
0007      IF(M.EQ.L1) GO TO 9
0008      M1=M+1
0009      45 FORMAT(1X,E12.5)
0010      WRITE(6,45) (K1(I),I=1,M1)
0011      IF(M1.EQ.L1) GO TO 10
0012      X1=(2*K1(M)+K1(M+1))/3.
0013      X2=(K1(M+1)+2*K1(M+2))/3.
0014      Y1=(2*K2W(M)+K2W(M+1))/3.
0015      Y2=(K2W(M+1)+2*K2W(M+2))/3.
0016      IF(Y1.EQ.Y2) GO TO 10
0017      TAU=(X2-X1)/(Y1-Y2)
0018      IF(TAU.EQ.0.0) GO TO 30
0019      K2WO=Y1+X1/TAU
0020      GO TO 31
0021      30 K2WO=0.
0022      31 M777=M1
0023      GO TO 9
0024      10 IF(K2W(M).EQ.K2W(M+1)) GO TO 11
0025      TAU=(K1(M+1)-K1(M))/(K2W(M)-K2W(M+1))
0026      GO TO 12
0027      11 WRITE(6,20)
0028      20 FORMAT(1X,'LINE K2W(M+1)=K2W(M) FIX UP D1 NOT CHANGE TAU')
0029      GO TO 9
0030      12 M777=M1
0031      5 RETURN
0032      END

```

TOTAL MEMCRY REQUIREMENTS 00040E BYTES

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## II. MINERALS, ROCKS, SOILS, MISCELLANEOUS INORGANICS

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Note: In the following data sheets  $\kappa'$  (or  $\kappa'$ ) is the dielectric constant relative to air;  $\kappa''$  is the loss factor;  $\tan \delta$  is the loss tangent;  $\rho$  is the resistivity in ohm-cm.

# I. INORGANIC COMPOUNDS

Aluminum oxide, single crystal

Sapphire  $\text{Al}_2\text{O}_3$

Union Carbide Corporation  
Electronics Division  
8888 Balboa Ave.  
San Diego, Calif. 92123

Loss tangents at 8.5 GHz, 25°C:  $E \perp c$ , <.00002

$E \parallel c$ , <.00005

Dielectric constants at ~3 GHz:

T°C	$E \perp c$	$E \parallel c$
25	9.390*	11.584*
-75	9.292	11.433
-195	9.257	11.357

Variation of dielectric constant at 25°C with inclination of electric field direction with respect to optic axis was calculated from elliptic polarization function:

$$\kappa = \left[ \frac{11.584^2 \times 9.39^2 (1 + \cot^2 \theta)}{11.584^2 + 9.39^2 \cot^2 \theta} \right]^{1/2}$$

$\theta^\circ$	$\kappa$
10	11.494
20	11.246
30	10.895
40	10.507
50	10.1295
60	9.820
70	9.584
80	9.439

Average  $\kappa$  for random oriented full-density ceramic:

$$\kappa_{av} = 10.071 \text{ from } \kappa_{av} = (9.39 \times 9.39 \times 11.584)^{1/3}$$

$$\text{or } 10.121 \text{ for approximate value, } \frac{11.584 + 2 \times 9.390}{3}$$

\* These values are in reasonable agreement with optically measured values of 11.56 and 9.406 [E. E. Russell and Bell, J. Opt. Soc. Amer. 57, 543 (1967)].

Aluminum oxide, multicrystalline

AT-100 (near 100%  $\text{Al}_2\text{O}_3$ , fine grained)

Density,  $\text{g/cm}^3$ : ( $10^2$  to  $10^8$  Hz) - 3.956  
(4; 8 GHz) - 3.955

General Electric Company  
Electronic Components Division  
Microwave Tube Business Section  
One River Road  
Schenectady, N.Y. 12305

T°C	Frequency in Hz						
	$10^2$	$10^3$	$10^4$	$10^5$	$10^6$	$10^7$	$8.5 \times 10^9$
25 $\kappa$	9.98	9.98	9.98	9.98	9.98	9.98	9.96
$10^6 \tan \delta$	7	<1	<1	<1	<1.5	<7	48
100 $\kappa$	10.09	10.09	10.09	10.09	10.09	10.09	
$10^6 \tan \delta$	52	6	<1	<1	<1.5	<7	
200 $\kappa$	10.21	10.21	10.21	10.21	10.21	10.21	
$10^6 \tan \delta$	603	128	45	20	10	<7	
300 $\kappa$	10.42	10.37	10.355	10.35	10.35	10.35	
$10^4 \tan \delta$	61.3	16.3	5.27	2.28	.62	.12	
400 $\kappa$	10.84	10.68	10.57	10.46	10.44	10.44	
$\tan \delta$	.0307	.0133	.00407	.00103	.00034	.00006	
500 $\kappa$	12.60	11.28	10.86	10.71	10.63	10.62	
$\tan \delta$	.289	.069	.0237	.0044	.00082	.0002	

A-976 (near 100%)

T°C	Frequency in Hz						
	$10^2$	$10^3$	$10^4$	$10^5$	$10^6$	$10^7$	$8.5 \times 10^9$
25 $\kappa$	9.90	9.90	9.90	9.90	9.90	9.90	9.81
$10^6 \tan \delta$	70	34	20	10	<10	<10	66
100 $\kappa$	10.01	10.01	10.00	10.00	10.00	10.00	
$10^5 \tan \delta$	15	7	3	1.5	<1	<1	
200 $\kappa$	10.14	10.12	10.11	10.11	10.11	10.1	
$10^5 \tan \delta$	66	23	8	6	3	<1	
300 $\kappa$	10.32	10.29	10.26	10.26	10.26	10.26	
$10^4 \tan \delta$	25	11	3.8	1.1	.4	.2	
400 $\kappa$	10.65	10.50	10.43	10.42	10.41	10.41	
$10^4 \tan \delta$	395	102	27.8	8.7	2.9	1.0	
500 $\kappa$	11.30	10.81	10.65	10.59	10.58	10.56	
$10^3 \tan$	461	118	22.4	4.59	1.97	1.1	

Density of disk - 3.919; density of cylinder - 3.917

Aluminum oxide, multicrystalline

A-1000 (99.8%  $\text{Al}_2\text{O}_3$ , fine grained)

General Electric Company

Density,  $\text{g/cm}^3$ : ( $10^2$  to  $10^8$  Hz) - 3.900  
( $8.5 \times 10^9$ ) - 3.896

T°C	Frequency in Hz						
	$10^2$	$10^3$	$10^4$	$10^5$	$10^6$	$10^7$	$8.5 \times 10^9$
25 $\kappa$	10.08	10.08	10.07	10.04	9.98	9.96	9.77
tan $\delta$	.00048	.00048	.00135	.00354	.00664	.00612	.00258
100 $\kappa$	10.20	10.16	10.15	10.15	10.15	10.15	
tan $\delta$	.00124	.00077	.00037	.00058	.00208	.0061	
200 $\kappa$	10.39	10.36	10.33	10.33	10.31	10.29	
tan $\delta$	.00344	.00198	.00101	.00045	.00051	.00170	
300 $\kappa$	10.65	10.55	10.51	10.47	10.45	10.44	
tan $\delta$	.0193	.0059	.00226	.00079	.00049	.00065	
400 $\kappa$	11.86	10.89	10.68	10.63	10.60	10.58	
tan $\delta$	.213	.0461	.00936	.00206	.00076	.00057	
500 $\kappa$	33.3	13.98	11.28	10.83	10.80	10.76	
tan $\delta$	1.212	.525	.130	.0201	.00341	.00135	

A-919 (97%  $\text{Al}_2\text{O}_3$ , magnesia-free)

Density,  $\text{g/cm}^3$ : ( $10^2$  to  $10^8$  Hz) - 3.747  
( $8.5 \times 10^9$  Hz) - 3.750

T°C	Frequency in Hz						
	$10^2$	$10^3$	$10^4$	$10^5$	$10^6$	$10^7$	$8.5 \times 10^9$
25 $\kappa$	10.33	9.95	9.62	9.45	9.38	9.37	9.35
tan $\delta$	.0240	.0251	.0206	.0082	.00139	.00030	
100 $\kappa$	10.29	9.88	9.60	9.51	9.49	9.49	.00069
tan $\delta$	.0316	.0252	.0123	.00303	.00048	.00025	
200 $\kappa$	9.74	9.52	9.60	9.59	9.59	9.59	
tan $\delta$	.0210	.0046	.00089	.00021	.00006	<.0001	
300 $\kappa$	10.32	9.89	9.79	9.78	9.77	9.77	
tan $\delta$	.0760	.0237	.00475	.00097	.00033	.00010	
400 $\kappa$	14.38	11.13	10.18	9.96	9.90	9.89	
tan $\delta$	1.65	.295	.0590	.0106	.00195	.00063	
500 $\kappa$	16.56	13.67	11.44	10.37	10.08	10.03	
tan $\delta$		6.83	.866	.122	.0203	.0035	

Aluminum oxide, multicrystalline

A-923 (97%  $\text{Al}_2\text{O}_3$ )

General Electric Company

Density,  $\text{g/cm}^3$ : ( $10^2$  to  $10^8$  Hz) - 3.740  
( $8.5 \times 10^9$  Hz) - 3.740

	Frequency in Hz						
$T^\circ\text{C}$	$10^2$	$10^3$	$10^4$	$10^5$	$10^6$	$10^7$	$8.5 \times 10^9$
25 $\kappa$	10.26	10.23	10.10	9.61	9.28	9.27	9.24
tan $\delta$	.00227	.00432	.0173	.0357	.00952	.00165	.00067
100 $\kappa$	10.33	10.30	10.19	9.72	9.40	9.39	
tan $\delta$	.00330	.00352	.0178	.0320	.0118	.00157	
200 $\kappa$	10.18	9.73	9.55	9.53	9.50	9.50	
tan $\delta$	.0349	.0238	.0073	.00200	.0089	.00040	
300 $\kappa$	10.38	9.84	9.74	9.65	9.64	9.64	
tan $\delta$	.0678	.0232	.0074	.00313	.00167	.00112	
400 $\kappa$	12.50	10.48	9.97	9.82	9.80	9.79	
tan $\delta$	.205	.082	.0228	.00735	.0035	.0017	
500 $\kappa$	16.72	13.93	10.98	10.08	9.95	9.91	
tan $\delta$	8.03	1.20	.240	.0444	.00976	.0037	

A-1004 (94%  $\text{Al}_2\text{O}_3$ )

At  $25^\circ\text{C}$ :  $2 \times 10^4$  Hz,  $\kappa = 10.10$ , tan  $\delta = .0426$ ;  $5 \times 10^4$  Hz,  $\kappa = 9.76$ , tan  $\delta = .0536$ ;  
 $3 \times 10^5$ ,  $\kappa = 9.19$ , tan  $\delta = .0341$ .

Density,  $\text{g/cm}^3$ : ( $10^2$  to  $10^8$  Hz) - 3.645  
( $8.5 \times 10^9$  Hz) - 3.649

	Frequency in Hz						
$T^\circ\text{C}$	$10^2$	$10^3$	$10^4$	$10^5$	$10^6$	$10^7$	$8.5 \times 10^9$
25 $\kappa$	10.48	10.41	10.26	9.51	9.10	9.00	9.01
tan $\delta$	.00226	.00716	.0319	.0534	.0142	.00228	.00125
100 $\kappa$	10.63	10.55	10.48	9.89	9.19	9.10	
tan $\delta$	.00355	.00555	.0208	.0505	.0271	.0515	
200 $\kappa$	10.49	9.73	9.34	9.25	9.21	9.20	
tan $\delta$	.0450	.0439	.0171	.0047	.00163	.00105	
300 $\kappa$	10.52	9.81	9.55	9.44	9.37	9.36	
tan $\delta$	.0767	.043	.0132	.0059	.0022	.0020	
400 $\kappa$	12.63	10.39	9.78	9.54	9.43	9.36	
tan $\delta$	.227	.0887	.033	.0136	.0072	.0040	
500 $\kappa$	19.19	12.59	10.55	10.03	9.83	9.74	
tan $\delta$	1.16	.452	.121	.0298	.0133	.0071	

Boron nitride

Pyrolytic

Raytheon Company

Data supplementary to p. 40, Tech. Rep. 203

Post-treated samples, measured at 8.52 GHz, 25°C

Density (g/cm <sup>3</sup> )	$\kappa$	$\tan \delta$
1.233	2.994	.00008 $\pm$ .00002
1.237	3.013	.00005 $\pm$ .00003

Sample 2A + 2B, density at 25°C 1.381

T°C	5.07 to 5.00 GHz	
	$\kappa$	$\tan \delta$
25	3.199	<.0002
200	3.212	<.0002
400	3.226	<.0002
600	3.241	.0002 $\pm$ .0001
800	3.255	.0002 $\pm$ .0001
1000	3.272	.0002 $\pm$ .0001
1200	3.288	.0002 $\pm$ .0001
1300	3.297	.0003 $\pm$ .0002
1400	3.309	.0007 $\pm$ .0004



Test for anisotropic effects at 8.52 GHz, 25°C, by rotation and reversal of sample:

$$\kappa_{\max} = 3.0018$$

$$\kappa_{\min} = 2.9894$$

Pyrolytic laminate

Union Carbide

T°C	8.52 GHz E // laminate	
	$\kappa$	$\tan \delta$
25	5.15 $\pm$ .05	.00025 $\pm$ .00005
173		.00025 $\pm$ .0001
225		
341		
470		
610		
800		
978		.0003 $\pm$ .0001

Boron nitride, hot-pressed  
Grade HP, 25°C

The Carborundum Company  
Refractories & Electronics Division  
Whirlpool Technical Center  
Niagara Falls, N.Y., 14302

All  $\tan \delta$  values multiplied by  $10^4$

Field			All $\tan \delta$ values multiplied by $10^4$							
Sample No.	Density (g/cm <sup>3</sup> )	direct.	(Hz)	$10^2$	$10^3$	$10^4$	$10^5$	$10^6$	$10^7$	$10^8$
1	2.120	unknown	$\kappa$	4.59	4.56	4.54	4.54	4.54	4.54	4.54
			$\tan \delta$	8.5	3.58	2.30	2.3	2.3	2.8	3.5
2	1.762	$\perp$	$\kappa$	4.14	4.02	3.97	3.96	3.96	3.96b	
			$\tan \delta$	414	174	41.6	9.9	3.4	2.0	
3	2.131	$\parallel$	$\kappa$	4.71	4.64	4.54	4.46	4.40	4.32	
			$\tan \delta$	100	110	120	125	141	123	
			(Hz)	$3 \times 10^8$	$10^9$	$3 \times 10^9$	$8.5 \times 10^9$	$1.4 \times 10^{10}$	$2.4 \times 10^{10}$	
4 (various not meas.)		unknown	$\kappa$	4.59	4.59	4.59	4.39	4.62	4.57	
			$\tan \delta$	2.7	3.5	4.2	6.55	6.0	6.0	
5	1.999	unknown	$\kappa$							
			$\tan \delta$							
6	2.033	$\perp$	$\kappa$	4.47	4.468	4.457				
			$\tan \delta$	5.3	4.6	6.0				
7	1.748	mixed	$\kappa$	3.88	3.880	3.876				
			$\tan \delta$	4.1	4.7	4.0				
8	2.111	$\perp$	$\kappa$				4.584			
			$\tan \delta$				6.0			
9	2.061	$\perp$	$\kappa$				4.552			
			$\tan \delta$				7.1			
9	"	$\parallel$	$\kappa$				4.507			
			$\tan \delta$				7.7			
10	2.117	$\perp$	$\kappa$					4.75		
			$\tan \delta$					8.0		
11	2.063	$\perp$	$\kappa$					4.55		
			$\tan \delta$					8.7		
11	"	$\parallel$	$\kappa$					4.51		
			$\tan \delta$					8.8		
12	2.118	$\perp$	$\kappa$							4.69
			$\tan \delta$							8.5
13	2.066	$\perp$	$\kappa$							4.61
			$\tan \delta$							7.9
13	"	$\parallel$	$\kappa$							4.48
			$\tan \delta$							9.2



Boron nitride, hot-pressed  
Grade A, 25°C

Carborundum

All tan $\delta$ values are multiplied by $10^4$										
Sample No.	Density (g/cm <sup>3</sup> )	Field direct.		(Hz) $10^2$	$10^3$	$10^4$	$10^5$	$10^6$	$10^7$	$10^8$
1	2.084	unknown	$\kappa$	4.13	4.12	4.090	4.087	4.086	4.080	4.08
			$\tan\delta$	11.8	10.4	7.9	4.3	3.1	2.7	2.6
2	2.040	$\perp$	$\kappa$	4.40	4.40	4.39	4.39	4.39	4.38	
			$\tan\delta$	8.7	6.3	6.0	3.1	1.8	1.0	
3	2.066	$\parallel$	$\kappa$	3.99	3.99	3.98	3.98	3.98	3.97	
			$\tan\delta$	6.9	5.6	4.5	3.0	2.4	1.1	
4 (various not meas.)		unknown	$\kappa$	(Hz) $3 \times 10^8$	$10^9$	$3 \times 10^9$	$8.5 \times 10^9$	$1.4 \times 10^{10}$	$2.4 \times 10^{10}$	
			$\tan\delta$	4.46	4.46	4.46		4.6	4.61	
5	2.099	unknown	$\kappa$	4.0	3.3	3.4		5.8	3.5	
			$\tan\delta$							
6	2.091	$\perp$	$\kappa$				4.605			
			$\tan\delta$				20			
7	2.097	mixed	$\kappa$	4.62	4.615	4.599				
			$\tan\delta$	2.6	3.7	3.8				
8	2.069	$\perp$	$\kappa$	4.36	4.359	4.352				
			$\tan\delta$	2.2	1.3	1.5				
9	2.077	$\perp$	$\kappa$				4.586			
			$\tan\delta$				6.4			
9	"	$\parallel$	$\kappa$				4.550			
			$\tan\delta$				3.6			
10		$\perp$	$\kappa$				4.268			
			$\tan\delta$				4.5			
11	2.093	$\perp$	$\kappa$				4.53			
			$\tan\delta$				4.5			
11	"	$\parallel$	$\kappa$				4.28			
			$\tan\delta$				10.4			
12	2.090	$\perp$	$\kappa$						4.56	
			$\tan\delta$						5.3	
13	2.095	$\perp$	$\kappa$						4.54	
			$\tan\delta$						4.6	
13	"	$\parallel$	$\kappa$						4.24	
			$\tan\delta$						3.2	

Boron nitride, hot-pressed, with silica  
Grade M, 25°C

Carborundum

Sample No.	Density (g/cm <sup>3</sup> )	Field direct.	(Hz)	All tan $\delta$ values multiplied by 10 <sup>4</sup>						
				10 <sup>2</sup>	10 <sup>3</sup>	10 <sup>4</sup>	10 <sup>5</sup>	10 <sup>6</sup>	10 <sup>7</sup>	10 <sup>8</sup>
1	2.143	unknown	$\kappa$	3.71	3.70	3.69	3.69	3.69	3.68	3.68
			$\tan\delta$	4.0	2.78	2.22	2.07	1.63	1.8	2.3
2	2.107	$\perp$	$\kappa$	4.34	4.33	4.32	4.30	4.30	4.30	
			$\tan\delta$	16.9	14.3	10.5	6.6	3.7	1.9	
3	2.109	$\parallel$	$\kappa$	3.76	3.76	3.76	3.75	3.75	3.75	
			$\tan\delta$	7.4	7.0	6.7	4.6	3.4	3.6	
			(Hz)	3x10 <sup>8</sup>	10 <sup>9</sup>	3x10 <sup>9</sup>	8.5x10 <sup>9</sup>	1.4x10 <sup>10</sup>	2.4x10 <sup>10</sup>	
4	(various not meas.)		$\kappa$	4.24	4.24	4.24		4.32		
			$\tan\delta$	2.8	3.1	3.7		5.5		
5	2.145		$\kappa$				4.328			
			$\tan\delta$				4.1			
6	2.137	$\perp$	$\kappa$	4.27	4.27	4.255				
			$\tan\delta$	3.8	4.9	4.9				
7	2.118	mixed	$\kappa$	3.99	3.992	3.983				
			$\tan\delta$	3.9	4.5	5.2				
8	2.095	$\perp$	$\kappa$				4.192			
			$\tan\delta$				6.6			
9	2.120	$\perp$	$\kappa$				4.332			
			$\tan\delta$				6.2			
9		$\parallel$	$\kappa$				3.668			
			$\tan\delta$				8.5			
10	2.125	$\perp$	$\kappa$					4.23		
			$\tan\delta$					5.4		
11	2.123	$\perp$	$\kappa$					4.295		
			$\tan\delta$					11.0		
11	"	$\perp$	$\kappa$					3.63		
			$\tan\delta$					7.8		
12	2.066	$\perp$	$\kappa$							4.22
			$\tan\delta$							5.1
13	2.121	$\perp$	$\kappa$							4.28
			$\tan\delta$							7.9
	"	$\parallel$	$\kappa$							3.64
			$\tan\delta$							10.5

Boron nitride, hot-pressed  
Grade HBR

Union Carbide Corporation  
Carbon Products Division  
270 Park Ave.  
New York, N.Y., 10017

E  $\perp$  direction of pressing

T°C		10 <sup>2</sup>	10 <sup>3</sup>	10 <sup>4</sup>	10 <sup>5</sup>	10 <sup>6</sup>	10 <sup>7</sup>
25	$\kappa$	4.77	4.77	4.76	4.76	4.76	4.76
	10 <sup>4</sup> tan $\delta$	18.2	7.1	4.9	1.5	1.4	0.9
100	$\kappa$	4.85	4.80	4.78	4.78	4.78	4.78
	10 <sup>4</sup> tan $\delta$	165	45.4	9.4	4.1	2.1	0.6
200	$\kappa$	5.26	4.96	4.85	4.82	4.81	4.81
	10 <sup>4</sup> tan $\delta$	596	277	101	39	5.4	23
300	$\kappa$	5.75	5.25	5.00	4.89	4.85	4.85
	10 <sup>4</sup> tan $\delta$	855	526	231	109	33.8	12.5
400	$\kappa$	6.75	5.70	5.21	5.00	4.88	4.87
	10 <sup>4</sup> tan $\delta$	28.0	11.57	4.95	2.3	1.2	.37
500	$\kappa$	8.07	6.46	5.62	5.31	5.08	4.93
	tan $\delta$	1.994	.389	.109	.0419	.024	.014

Boron nitride, hot-pressed

Grade HD 0092,  
Density 1.9745 g/cm<sup>3</sup>  
At 8.52 GHz

Grade HD 0093  
Density 1.9165 g/cm<sup>3</sup>  
At 3.52 GHz

$\kappa_{\min} = 3.993$  tan  $\delta = 0.00025$   
 $\kappa_{\max} = 4.091$  tan  $\delta = 0.00026$

$\kappa' = 3.998 \pm 0.002$   
tan  $\delta = 0.00052$

T°C	At 4.54 to 4.47 GHz		T°C	At 4.53 to 4.44 GHz	
	$\kappa$	tan $\delta$		$\kappa$	tan $\delta$
25	4.08	.00026	25	4.003	.0005
113	4.08	.0003	207	4.048	.0004
185	4.09	.0005	393	4.072	.00045
322	4.09	.00055	513	4.088	.0004
423	4.10	.00040	593	4.101	.0007
530	4.11	.00035	798	4.146	.0030
639	4.12	.00040	852	4.166	.0052
752	4.13	.00045	891	4.204	.0040
863	4.13	.00050	1018	4.320	.0028
943	4.14	.00050	1077	4.479	.0057
1021	4.15	.00055	1094	4.485	.0071
1096	4.16	.00080	1110	4.54	.01
1170	4.16	.0013	943	4.25	.0026
1219	4.17	.0019	860	4.19	
1287	4.18	.0034	25	4.01	
1373	4.19	.0040			
1427	4.20	.0028			
1446	4.22	.0023			
1460	4.24	.0044			
1470	4.24	.0046			

Density check after run 1.916

# Boron nitride, hot pressed

Grade HD 0094, at 8.52 GHz

Sample 2: density 1.303 g/cm<sup>3</sup>

T°C	$\kappa$	$\tan \delta$
25	3.004	.00033

Sample 1: density 1.307 g/cm<sup>3</sup>

T°C	$\kappa$	$\tan \delta$
25	3.016	.00033
93	3.02 $\pm$ .03	.00030
192		.00035
339		.00037
471		.00040
602	3.04 $\pm$ .03	.00040
705		.00047
754		.00060
793		.00095
843		.0020
954		.0085
999		.0135

Union Carbide

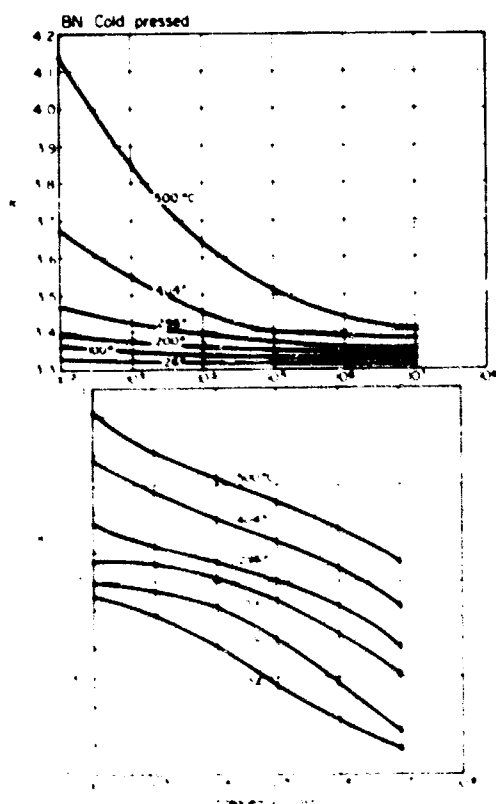
At 5.30 to 5.26 GHz

Density: 1.303 g/cm<sup>3</sup>

T°C	$\kappa$	$\tan \delta$
25	3.004	.00033
120	3.008	.00037
203	3.012	.00039
325	3.018	.00044
404	3.021	.00043
498	3.026	.00046
601	3.032	.00046
721	3.039	.00065
812	3.047	.00186
884	3.053	.00447
908		>.01

# Boron nitride, cold-pressed

Union Carbide



Rod sample, at 8.52 GHz

Density: 1.474 g/cm<sup>3</sup>

At 25°C:

$$\kappa' = 3.412; \tan \delta = .00046$$

Magnesium aluminate (spinel)  $\text{MgOAl}_2\text{O}_3$

Single crystal

Union Carbide

Density at  $25.0^\circ$ ,  $3.57389 \text{ g/cm}^3$

At  $8.52$ ,  $25^\circ\text{C}$ :  $\kappa' = 8.26 \pm .04$

$\tan \delta = .00009 \pm .00002$

Magnesium orthosilicate, multicrystalline

General Electric

F-118 Density: disk  $3.087$ , cylinder  $3.071 \text{ g/cm}^3$

Freq. Hz	$25^\circ\text{C}$		$100^\circ\text{C}$		$200^\circ\text{C}$		$300^\circ\text{C}$		$400^\circ\text{C}$		$500^\circ\text{C}$		$550^\circ\text{C}$	
	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$
$10^2$	6.625	.00098	6.70	.00445	6.80	.00134	6.91	.00636	7.23	.0662	8.78	.421		
$10^3$	6.62	.00027		.00065	6.79	.00076	6.89	.00198	7.04	.0127	7.44	.0890		
$2 \times 10^3$				.00086										
$3 \times 10^3$				.00098	6.78	.00057								
$4 \times 10^3$				.00109										
$5 \times 10^3$				.00110										
$6 \times 10^3$				.00107										
$8 \times 10^3$				.00102										
$10^4$	6.62	.00013	6.70	.00090	6.78	.00044	6.88	.00090	6.96	.00334	7.20	.0188		
$10^5$	6.62	.000110	6.69	.00024	6.78	.00064	6.87	.00051	6.96	.00123	7.14	.0049		
$5 \times 10^5$					6.77	.00098								
$10^6$	6.62	.000072	6.69	.00016	6.77	.00074	6.85	.00046	6.94	.00069	7.09	.00329		
$10^7$	6.62	.00011	6.69	.00024	6.77	.00025	6.84	.00083	6.95	.00023	7.08	.00149		
$10^8$														
$8.5 \times 10^9$	6.59	.00083	6.64	.00086	6.73	.00092	6.81	.00100	6.90	.00109	6.98	.00119	7.03	.00124
$1.4 \times 10^{10}$														
$2.4 \times 10^{10}$														

Freq. Hz	$25^\circ\text{C}$		$100^\circ\text{C}$		$200^\circ\text{C}$		$300^\circ\text{C}$		$400^\circ\text{C}$		$500^\circ\text{C}$		$550^\circ\text{C}$	
	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$
$10^2$	6.77	.000515	6.86	.00107	6.99	.00277	7.26	.02835	9.74	.508	14.73	4.29		
$10^3$	6.76	.000293	6.85	.00063	6.98	.00202	7.14	.0076	7.70	.142	10.08	.822		
$10^4$	6.76	.000240	6.84	.00056	6.96	.00124	7.08	.0037	7.34	.0293	8.13	.178		
$10^5$	6.76	.000233	6.83	.00035	6.95	.00077	7.06	.0017	7.22	.00705	7.40	.0474		
$10^6$	6.76	.000245	6.83	.00032	6.94	.00067	7.06	.00120	7.18	.0025	7.31	.00975		
$10^7$	6.76	.00025	6.83	.00025	6.94	.00052	7.05	.00098	7.15	.00153	7.28	.00394		
$10^8$														
$8.5 \times 10^9$	6.74	.00080	6.81	.00090	6.92	.0015	7.02	.0014	7.13	.0019	7.23	.0027	7.28	.0031
$1.4 \times 10^{10}$														
$2.4 \times 10^{10}$														

Density of disk  $3.087$ , cylinder  $3.086 \text{ g/cm}^3$

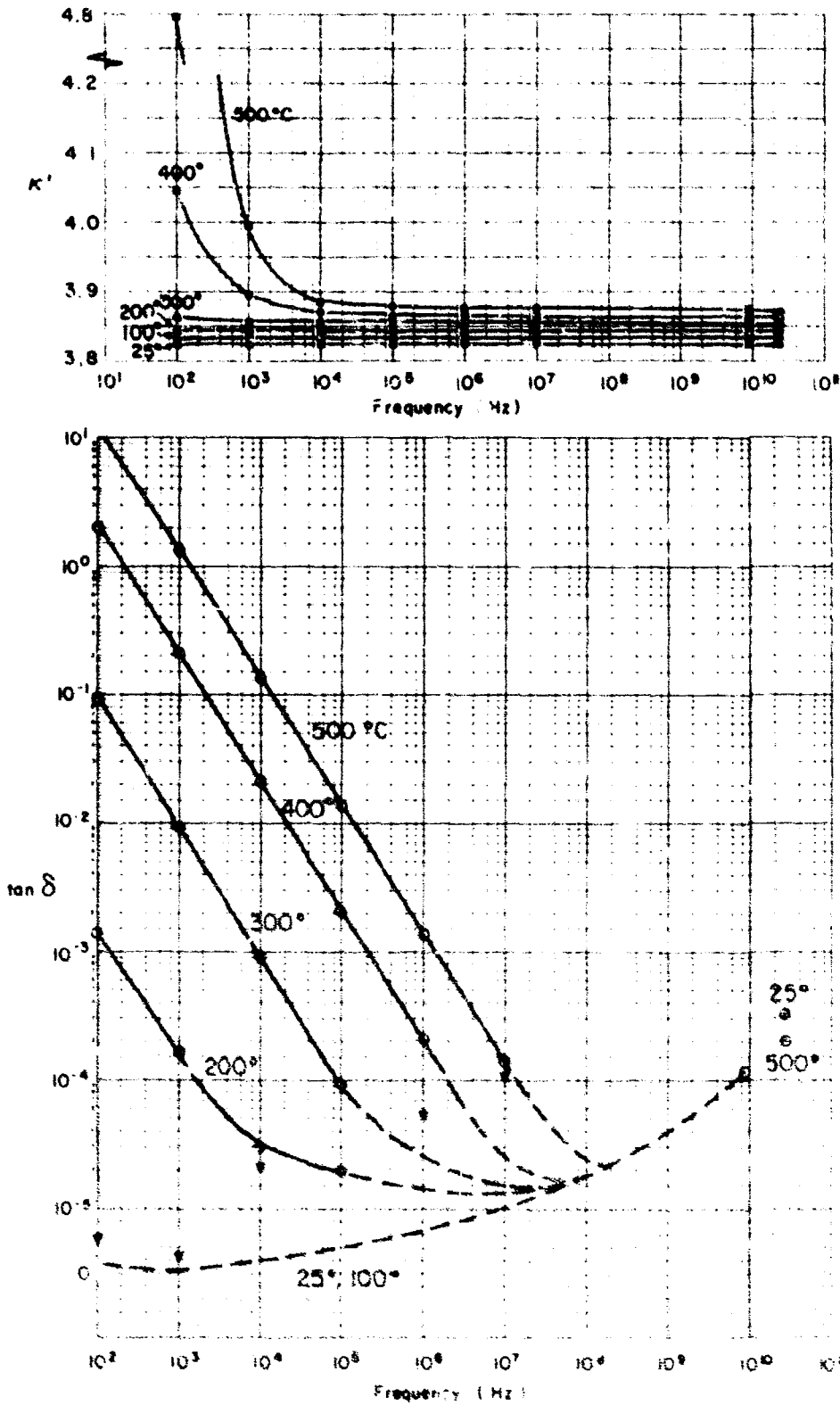
Mercuric compounds, hot-pressed

Heort. density	Compound	Sample No.	Density (g/cm <sup>3</sup> )	T°C	10 <sup>2</sup>	10 <sup>3</sup>	10 <sup>4</sup>	10 <sup>5</sup>	10 <sup>6</sup>	10 <sup>7</sup>	8.5x10 <sup>9</sup>
6.27	HgI <sub>2</sub>	1	-	25	κ	13.7			11.8		13.4
					tan δ	.191			.0034		.0037
		2	5.48	25	κ	14.3			12.57		
					tan δ	.208			.0026		
		3	5.49	25	κ						13.9
					tan δ						< .003
		4	5.56	25	κ	16.11	13.15	12.41	12.39	12.38	12.37
					tan δ	.828	.154	.0268	.00427	.00117	.00043
				50	κ	44.35	16.87	13.50	12.98	12.90	12.85
					tan δ	2.33	.888	.168	.0264	.0047	.00095
				25	κ	15.45	13.03	12.45	12.42	12.41	12.40
					tan δ	.713	.185	.0334	.0057	.00149	.00076
7.15	HgCl	1	5.36	25	κ	7.49	7.48	7.48	7.46	7.45	
					tan δ	.0013	.00044	.00029	.00034	.00040	.00029
				50	κ	7.62	7.61	2.59	7.58	7.57	7.57
					tan δ	.00328	.00095	.00046	.00021	.00028	.00039
				25	κ	7.58	7.58	7.57	7.56	7.56	
					tan δ	.00050	.00027	.00018	.00021	.00034	.00046
7.73	HgS	1	5.19	25	κ	9.75	9.72	9.68	9.64	9.62	9.58
					tan δ	.0038	.0035	.0029	.0021	.0017	.0011
				50	κ	9.64	9.61	9.58	9.56	9.53	9.49
					tan δ	.00324	.00225	.00188	.00174	.00181	.00144
				25	κ	9.63	9.62	9.62	9.61	9.58	9.57
					tan δ	.00207	.00177	.00162	.00165	.00147	.00119

Silicon dioxide, high purity glasses

Dynasil 4000

Dynasil Corporation of America  
Berlin, New Jersey 08009



Silicon dioxide, high-purity glasses (cont.)

Spectrosil A

Thermal American Fused Quartz Co.  
Montville, N.J. 07045

25°C, 8.52 GHz:  $\kappa' = 3.826 \pm .003$

$10^4 \tan \delta = 1.9 \pm .4$

Spectrosil B

25°C, 8.52 GHz:  $\kappa' = 3.825 \pm .003$

$10^4 \tan \delta = 1.5 \pm .2$

Frequency in Hz

T°C		10 <sup>2</sup>	10 <sup>3</sup>	10 <sup>4</sup>	10 <sup>5</sup>	10 <sup>6</sup>	10 <sup>7</sup>
25	$\kappa$	3.823	3.823	3.823	3.823	3.823	3.823
	$10^6 \tan \delta$	<4	<4	6	7	<40	<130
100	$\kappa$	3.83	3.83	3.83	3.83	3.83	3.83
	$10^6 \tan \delta$	<4	<4	<8	<10	<40	<130
197	$\kappa$	3.84	3.84	3.84	3.84	3.84	3.84
	$10^6 \tan \delta$	264	44	15	<20	<40	<130
300	$\kappa$	3.86	3.86	3.86	3.86	3.86	3.86
	$10^4 \tan \delta$	151	15.9	2	<.4	<.6	<1.3
398	$\kappa$	3.89	3.86	3.86	3.86	3.86	3.86
	$10^2 \tan \delta$	15.9	1.76	.219	.04	<.02	<.02
486	$\kappa$	3.98	3.89	3.87	3.87	3.87	3.87
	$\tan \delta$	.79	.0883	.00954	.0015	.0005	.0002

Vitreosil, optical grade

25°C, 8.52 GHz,  $\kappa' = 3.811 \pm .005$ ;  $10^4 \tan \delta = 1.17 \pm .2$

Vitreosil, commercial grade

25°C, 8.52 GHz,  $\kappa' = 3.805 \pm .01$ ;  $10^4 \tan \delta = .80 \pm .13$



## Silicon dioxide, sintered

Slip-cast

Density 1.957 g/cm<sup>3</sup>

Brunswick

Freq., Hz	25°C		100°C		200°C		300°C		400°C		500°C	
	$\kappa$	$10^4 \tan \delta$	$\kappa$	$10^4 \tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$
10 <sup>2</sup>	3.38	7.1	3.39	11.0	3.44	.0190	4.42	.896	7.91	9.51	19.1	33.8
3x10 <sup>2</sup>	3.38	8.6										
10 <sup>3</sup>	3.38	8.8	3.38	7.8	3.41	.99364	3.64	.178	5.09	1.66	7.57	9.00
2x10 <sup>3</sup>	3.38	7.3										
5x10 <sup>3</sup>			3.38	7.7								
10 <sup>4</sup>	3.37	6.2	3.38	7.6	3.41	.00158	3.47	.0246	3.90	.334	5.10	1.47
5x10 <sup>4</sup>			3.38	8.3					3.5			
10 <sup>5</sup>	3.37	4.5	3.37	8.3	3.41	.00099	3.46	.00465	3.54	.055	3.90	.290
2x10 <sup>5</sup>			3.37	7.5								
10 <sup>6</sup>	3.37	3.7	3.37	6.1	3.40	.00081	3.45	.00158	3.49	.0089	3.61	.0483
6x10 <sup>6</sup>			3.37	3.6								
10 <sup>7</sup>	3.37	2.5	3.37	3.2	3.40	.00068	3.45	.0008	3.49	.0021	3.55	.0112
8.5x10 <sup>9</sup>	3.364	6.6										

## Silicon dioxide, with 2.5% chromium oxide

Brunswick

Slip-cast,

Density 1.928 g/cm<sup>3</sup>

Freq., Hz	25°C		100°C		200°C		300°C		400°C		500°C	
	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$
10 <sup>2</sup>	3.33	.00345	3.43	.0057	3.57	.0292	4.59	.935	8.73	9.39	36.7	42.4
10 <sup>3</sup>	3.33	.00257	3.42	.0043	3.51	.0113	3.72	.179	5.17	1.76	13.5	10.1
10 <sup>4</sup>	3.32	.00174	3.36	.0034	3.48	.0071	3.59	.0292	3.95	.324	6.09	2.41
10 <sup>5</sup>	3.32	.00152	3.34	.0027	3.40	.0054	3.51	.0109	3.63	.0537	4.39	.425
10 <sup>6</sup>	3.31	.00093	3.33	.0020	3.38	.0040	3.49	.0101	3.56	.0149	3.82	.094
10 <sup>7</sup>	3.31	.00035	3.32	.0017	3.34	.0022	3.42	.0076	3.53	.0106	3.68	.032
8.5x10 <sup>9</sup>	3.29	.00112										

Silicon Dioxide, sintered

Code 7941

Density 1.923 g/cm<sup>3</sup>

Corning Glass

Freq., ~8.5 GHz

Corning Multiform Glass

T°C	$\kappa$	tan $\delta$
25	3.323	.0005
279	3.351	.0009
517	3.378	.0014
769	3.408	.0023
910	3.431	.0028
1043	3.451	.0037
1205	3.455	.0051
1372	3.513	.0091

At 8.52 GHz, 25°C, density = 1.906 g/cm<sup>3</sup>

$\kappa = 3.27$ ; tan  $\delta = .00063$

Quartz fiber

Sample AS-3DX-1R

Source: Philco Ford Corp.  
Newport Beach, Calif. 92663

Manufacturer: Fiber Materials Inc.  
Graniteville, Mass. 01829

Freq., 8.52 GHz

T°C	$\kappa$	tan $\delta$
25*	3.02	.0054
25	2.98	.0019
98	2.97	.0018
198	2.96	.0016
307	2.95	.0015
418	2.95	.0014
497	2.945	.0014
591	2.95	.0016
729	2.96	.0022
828	2.975	.0029
905	2.99	.0035
995	3.01	.0042

\* As received, other values after vacuum bake  
for 24 hours at 125°C.

# Glasses

Sample EE 9

Sample EE 10

Owens-Illinois  
Toledo, Ohio 43601

EE 9 Freq., 8.52 GHz			EE 10 Freq., 8.52 GHz		
T°C	$\kappa$	$\tan \delta$	T°C	$\kappa$	$\tan \delta$
25	5.84	.0070	25	8.17	.0082
97	5.86	.0070	97	8.25	.0082
199	5.90	.0071	202	8.36	.0083
314	5.97	.0072	292	8.47	.0084
421	6.02	.0074	416	8.63	.0089
506	6.08	.0077	501	8.76	.0096
607	6.17	.0081	605	8.98	.0123
32	5.82	.0069	27	8.19	.0080

## II. MINERALS, ROCKS, SOILS, MISCELLANEOUS INORGANICS

### Rocks

Hawaiian, high-density basalt\*

50% relative humidity

Density 2.717 g/cm <sup>3</sup>						
	Sample 1	Sample 2	Sample 3	Sample 3	Sample 3	Sample 4
Freq. (Hz)	$3 \times 10^8$	$10^7$	$3 \times 10^8$	$10^9$	$3 \times 10^9$	$9.5 \times 10^9$
$\kappa$	8.36	9.90	9.30	9.08	8.85	8.40
$\tan \delta$	.043	.080	.034	.033	.037	.04
$\mu'/\mu_0$	1.174	1.17	1.113	1.10	1.08	1.01
$\tan \delta_m$	.0077	<.002	.0075	.026	.072	.06

Hawaiian low-density basalt\*

50% relative humidity

Freq. (Hz)	$10^7$	$3 \times 10^8$	$10^9$	$3 \times 10^9$
$\kappa$	4.9	3.74	3.51	3.30
$\tan \delta$	.068	.085	.0481	.053
$\mu'/\mu_0$	1.047	1.047	1.040	1.035
$\tan \delta_m$	<.002	.0040	.002	.002

\* Data supplementary to Tech. Rep. 203, Lab. Inv. Res., Mass. Inst. Tech., Jan. 1967.

# Rocks (cont.)

Deep ocean basalt

No change after heating to 200°C

Freq. (Hz)	$10^5$	$10^6$	$10^7$	$8.5 \times 10^9$
$\kappa$	188	153	124	10.2
$\tan \delta$	93.5	11.6	.146	.560
$\rho$	1025	1015	995	36.9

# Soils

Hawaiian soil saturated with distilled  $H_2O$ \*

%  $H_2O$  on dry weight basis = 127.5

%  $H_2O$  on volume basis = 63.0

Density 1.303 g/cm<sup>3</sup>

Freq. (Hz)	$10^3$	$10^4$	$10^5$	$10^6$	$9.5 \times 10^6$	$7 \times 10^7$
$\kappa$	29,700	988	230	1295	81.5	64.2
$\tan \delta$	135	43.9	20.05	3.32	.776	.185

Hawaiian soil\* with approximately 25%  $H_2O$   
on dry weight basis. Density  $\approx$  .88 g/cm<sup>3</sup>.

Freq. (Hz)	$10^2$	$10^3$	$10^4$	$10^5$	$10^6$	$10^7$	$3 \times 10^8$	$1 \times 10^9$	$3 \times 10^9$	$8.5 \times 10^9$
$\kappa$	10560	940	68.0	21.66	12.04	6.88	5.12	4.90	4.45	3.97
$\tan \delta$	2.30	4.43	7.25	2.67	.827	.389	.105	.079	.81	.135

Synthetic basalt and lunar rocks, Apollo 11 and 12, see:

D. H. Chung, W. B. Westphal, and G. Simmons, "Dielectric Properties of Apollo 11 Lunar Samples and Their Comparison with Earth Materials," J. Geophys. Res. 75, 1970 (in press).

D. H. Chung, W. B. Westphal, and G. Simmons, "Dielectric Properties of Apollo 12 Lunar Samples," a paper (T64c) presented at American Geophys. Union Meeting, April 23, 1970, Washington D.C.

\* Data supplementary to Tech. Rep. 203, Lab. Ins. Res., Mass. Inst. Tech., Jan. 1967.

Miscellaneous inorganics

Corning Code 0330

Corning Glass

3 GHz	25°C
$\kappa$	$\tan \delta$
6.58	.0055

Isomica 4950

General Electric Company

Vacuum baked for 36 hrs. at 125°C, E II sheet

Freq. (MHz)	$\kappa$	$\tan \delta$
300	5.33	.0013
8520	5.31	.00207
8520	5.32*	.0025*

\* 50% relative humidity.

III. ORGANIC COMPOUNDS

(Listed according to manufacturer or source)

Artificial concrete

American Concrete Products

Material measured to be isotropic in  $\kappa$  within .5%

Freq. (MHz)	150	300	1000	3000
$\kappa$	6.06	6.04	6.02	6.0
$\tan \delta$	.0107	.0134	.0125	.0123

Conformal coating 1517-36-3

Amicon Corporation

25°C, 50% relative humidity

Freq. (Hz)	$\kappa$	$\tan \delta$
$10^2$	4.31	.0206
$10^3$	4.21	.0204
$10^6$	3.76	.0298

Volume resistivity  $3.7 \times 10^{13}$  ohm-cm

Surface resistivity  $>6 \times 10^{14}$  ohms per square

Polyethylene, irradiated  
At 25°C

Source: Amphenol Corp.

Freq. (Hz)	$\kappa'$	$\tan \delta$
$10^3$	$2.28 \pm .02$	$.59 \pm .05$
$10^6$		$.82 \pm .05$
$10^8$		$2.3 \pm .3$
$4 \times 10^8$	$2.27 \pm .02$	$2.9 \pm .5$
$10^9$	$2.27 \pm .01$	$2.8 \pm .3$
$3 \times 10^9$		$2.6 \pm .3$
$8.5 \times 10^9$	$2.26 \pm .01$ $2.26 \pm .005$	$2.5 \pm .2$

Polypropylene

Avisun Corporation  
Post Road  
Markus Hook, Pa. 19061

Freq., Hz	T°C	Natural		Plateable 12-270A	
		$\kappa$	$10^4 \tan \delta$	$\kappa$	$10^4 \tan \delta$
$10^2$	25	2.26	1.50	2.41	15.2
$2 \times 10^2$			1.30		
$4 \times 10^2$			1.18		
$10^3$			1.36	2.41	11.8
$3 \times 10^3$			1.50		
$10^4$			1.65	2.39	10.5
$2 \times 10^4$			1.68		
$5 \times 10^4$			1.66		
$10^5$		2.25	1.51	2.38	8.70
$10^6$		2.25	0.96	2.37	7.25
$10^7$		2.25	1.26	2.36	6.55
$10^8$		2.25	2.04	2.36	8.2
$3 \times 10^8$		2.25	2.8	2.35	12.4
$10^9$		2.25	4.7	2.35	17.5
$3 \times 10^9$		2.25	4.0	2.35	15.7
$5 \times 10^9$	25	2.245	3.7	2.344	12.1
	-55	2.265	3.0	2.352	6.0
	-75	2.271	2.7		
	-195	2.308	$0.7 \pm 0.3$	2.375	2.8
$8.5 \times 10^9$	25	2.245	3.6	2.343	12.3

## Polypropylene (cont.)

Avisun Corporation

Natural, at 8.52 GHz

<u>Sample</u>	Density (g/cm <sup>3</sup> )	T°C	κ	tan δ
1 stacked sheet pcs		25	2.246	.00033
2 stacked injection molded pcs		25	2.236	.00035
3 rod	.9073	25	2.245	.00037

## Polypropylene, plateable

Avisun Corporation

12-270A, at 8.52 GHz

<u>Sample</u>	Density	T°C	κ	tan δ
4 stacked injection molded pcs	.9500	25	2.442	.00145
5 rod	.9303	25	2.343	.00123

## Polytetrafluoroethylene, fiberglass laminate

The Budd Company  
Polychemicals Division

DiClad-522, E 1 sheet		All values of tan δ multiplied by 10 <sup>4</sup>									
T°C	Freq. (Hz)	10	10 <sup>2</sup>	10 <sup>3</sup>	10 <sup>4</sup>	10 <sup>5</sup>	10 <sup>6</sup>	10 <sup>7</sup>	5.5x10 <sup>7</sup>	9x10 <sup>7</sup>	3.14x10 <sup>9</sup> *
25	κ	2.739	2.740	2.738	2.737	2.735	2.734	2.733	2.732	2.731	2.712
	1 tan δ	8.6	7.0	6.7	6.1	6.3	6.95	7.7	10.0	11.7	22.5
100	κ		2.710	2.705	2.704	2.698	2.696	2.683			2.680
	1 tan δ		11.1	8.10	8.25	7.17	7.07	7.7			31
250	κ		2.554	2.534	2.522	2.503	2.502	2.49			
	1 tan δ		79.0	36.3	20.35	14.9	11.6	10.6			
-78	κ		2.796	2.793	2.790	2.784	2.78	2.78			2.752
	1 tan δ		4.2	5.9	6.8	7.1	7.7	9.8			17
-195	κ	2.801	2.799	2.794	2.792	2.787					2.758
	1 tan δ	.0005	2.2	4.5	5.1	5.4					12
-269	κ	2.709	2.789	2.784	2.783	2.780					
	1 tan δ	.0003	1.2	2.0	2.2	2.1					

\* Copper cavity

E 11 sheet

T°C	Freq. (Hz)	3x10 <sup>8</sup>	10 <sup>9</sup>	3x10 <sup>9</sup>	8.5x10 <sup>9</sup>	1.4x10 <sup>10</sup>	2.4x10 <sup>10</sup>
25	κ	3.155	3.153	3.152	3.146	3.133	3.127
	tan δ	28	30	33	40	48	52
100	κ				3.11		
	tan δ				39		
-250	κ				3.03		
	tan δ				36		
-54	κ				3.17	3.13	
	tan δ				35	39	
-195	κ				3.22	3.12	
	tan δ				28	31	

Polytetrafluoroethylene film

Zitex

Density 0.463 g/cm<sup>3</sup>

25°C, 8.52 GHz:  $\kappa = 1.194$ ,  $\tan \delta = .00010$

Chemplast Inc.

150 Day Road

Wayne, N.J. 07470

Custom Materials

Custom Materials Inc.

Custom load 4101

Freq. (GHz)	T°C	$\kappa$	$\tan \delta_e$	$\mu'/\mu_0$	$\tan \delta_m$
3	25	13.8	.050	2.69	.451
8.5	25	13.3	.031	1.65	.747
8.5	-67	13.7	.006	1.57	.748
8.5	85	14.5	.051	1.68	.735

Custom 707-4

25°C, 8.52 GHz:  $\kappa = 4.04$ ,  $\tan \delta = .00090$

Custom 707-(3.75)

25°C, 8.52 GHz:  $\kappa = 3.753$ ,  $\tan \delta = .00076$

Sylgard 182

Dow Corning

T°C	1 MHz	$\kappa$	$\tan \delta$
25		2.86	.00132
70		2.72	.00080
25 again		-	.00109
25 (after 24 hrs. in H <sub>2</sub> O)	wt. gain .019%	2.86	.00142

Sylgard 184

Dow Corning

At 25°C

Freq. (Hz)	50	10 <sup>3</sup>	10 <sup>5</sup>	10 <sup>6</sup>
$\kappa$	2.86	2.86	2.84	2.84
10 <sup>4</sup> $\tan \delta$	2	10.2	18.4	14.0

Sylgard 184

Dow Corning

2nd sample at 1 MHz

T°C	$\kappa$	$\tan \delta$
25	2.88	.00123
70	2.70	.00071
25	-	.00040
25 (after 24 hrs in H <sub>2</sub> O)	wt. gain .025%	2.89 .00129



"Kapton"\*

E. I. DuPont de Nemours

Type 500 H film

At 25°C, 45% relative humidity

Electric field in plane of sheet,  $\kappa \pm .05$ ,  $\tan \delta \pm .0005$

After 48 hrs. at 100°C				
Freq. (GHz)	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$
0.3	3.43	.0074	-	-
1	3.40	.0076	3.30	.0041
3	3.37	.0080	3.28	.0044
8.5	3.33	.0087	3.26	.0047
24	3.25	.0098	-	-

After 12 to 18 hrs. vacuum bake at 425°C, 2 microns, 8.52 GHz:

$\kappa = 3.03 \pm 0.1$ ,  $\tan \delta = .0015 \pm .0003$

"Eccogel" 1265

Emerson & Cuming

T°C	Freq. (Hz)	60		10 <sup>3</sup>		10 <sup>6</sup>	
		$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$
25		7.60	.025	7.20	.0595	4.05	.1115
70						6.02	.0545
25 again						-	.0897
25 (after 24 hrs. in H <sub>2</sub> O) wt. gain 1.08%						5.38	.128

"Eccofoam FH"

Emerson & Cuming

3.938 lb/cu.ft.

8.52 GHz				24 GHz	
$\kappa$	$\tan \delta$			$\kappa$	$\tan \delta$
1.0856	.00161			1.0798	.00165

RTV-11

General Electric Company

At 1 MHz

T°C	$\kappa$	$\tan \delta$
25	3.25	.00285
70	3.05	.00372
25	-	.00242
25 (after 24 hrs in H <sub>2</sub> O) wt. gain .035%	3.31	.00543

\* Supplementing data given in Tech. Rep. 203.

At 1 MHz

T <sup>o</sup> C	κ	tan δ
25	3.06	.0273
70	3.73	.1373
25	-	.0245
25 (after 24 hrs. in H <sub>2</sub> O) wt. gain .274%	3.12	.0352

## Polyimide foams

Monsanto

At 8.52 GHz

	Density (lbs/cu.ft.)	T <sup>o</sup> C	κ	tan δ
HD-139	8.4	25	1.1439	.00277
		150	1.128	.00040
		304	1.118	.00045
		25	1.126	.0014
HD-140	16.7	25	1.301	.00507
		154	1.264	.00094
		307	1.260	.00121
		25	1.260	.00037
HD-144	21.8	25	1.412	.00635
		148	1.355	.00135
		303	1.382	.00190
		28	1.351	.0068

## Radar tape

At 14.2 GHz

Quantum Inc.  
Lufbery Ave.  
Wallingford, Conn.

T <sup>o</sup> C	κ	tan δ
25	3.56	.0132
150	3.37	.0055
320	3.32	.0074
477	3.36	.0130

T <sup>o</sup> C	3.7 GHz		4.3 GHz		Cavity length (inches)
	$\epsilon$	$\tan \delta$	$\epsilon$	$\tan \delta$	
25	2.476	.00156	2.317	.00125	2.015
81.5	2.458	.00176	2.301	.00153	2.042
106.8	2.447	.00178	2.289	.00140	2.055
125	2.438	.00176	2.282	.00142	2.067
152	2.425	.00166	2.268	.00149	2.083
176	2.412	.00160	2.255	.00155	2.106
202	2.399	.00159	2.239	.00167	2.127
250	2.370	.00165	2.203	.00202	2.159
310	2.301	.00182	2.130	.0024	2.320
362	2.031	.00225	1.878	.0015	2.869

# LIQUIDS

Fluorocarbon derivative P-10  
At 25°C

Allied Chemical Corp.  
Specialty Chemical Div.

Freq. (GHz)	$\kappa$	$\tan \delta$
1	1.92	.0050
3	1.93	.0140
8.52	1.89	.029
14	1.87	.038

Fluorinated ethers  
At 27°C  
T°C = -6 to 28

E. I. Dupont de Nemours & Co.  
Organic Chemicals Department

Freq. (Hz)	FPS-1418		FPS-1419		FPS-1420	
	b.p. 148°C		b.p. 101°C		b.p. 153°C	
	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$
$10^2$	1.890	$3 \times 10^{-6}$	1.859	$1.6 \times 10^{-5}$	2.570	$3.23 \times 10^{-3}$
$10^5$	1.890	$3 \times 10^{-6}$	1.859	$2 \times 10^{-6}$	2.570	$1.6 \times 10^{-5}$
$10^8$	1.888	.00243	1.857	$4.2 \times 10^{-4}$	2.53	.0126
$10^9$	1.851	.0142	1.833	.0042	2.420	.0952
$3 \times 10^9$	1.838	.0124	1.832	.0076	2.213	.0995
$8.5 \times 10^9$	1.797	.0068	1.798	.0084	2.026	.0907

Mullet oil

U. S. Bureau of Fisheries

Freq. (GHz)	$24 \pm 0.5^\circ\text{C}$		$10 \pm 1^\circ\text{C}$	
	$\kappa$	$\tan \delta$	$\kappa$	$\tan \delta$
1	2.54	.068	-	-
8.5	2.52	.0507	2.50	.0458
14	2.42	.0468	2.39	.0443
24	2.35	.0384	2.36	.0380

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Technical Report		
5. AUTHOR(S) (Last name, first name, initial)		
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		Air Force Materials Laboratory Air Force Systems Command Wright-Patterson Air Force Base, Ohio
13. ABSTRACT		
<p>Extensions of the laboratory's measuring techniques for complex dielectric constants to wider ranges of temperature (4° to 2000°K) and frequency (.008 Hz to 90 GHz) are reviewed. Methods of interpreting dielectric data and computer programs for finding the components of complex spectra are discussed. Measurement data of general interest accumulated in the last three years appear in graphical and/or tabular form.</p>		

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14. KEY WORDS	LINK A		LINK B		LINK C	
	ROLE	WT	ROLE	WT	ROLE	WT
Dielectric constant measurements						
Dielectric loss measurements						
High-temperature materials						
Relaxation spectrum analysis						

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